

## AR1000 Series Resistive

# Touch Screen Controller Data Sheet

© 2009-2012 Microchip Technology Inc.

#### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
  mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION. QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

## QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

#### Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC<sup>32</sup> logo, rfPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2009-2012, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

ISBN: 9781620761366

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and mulfacture of development systems is ISO 9001:2000 certified.



## AR1000 SERIES RESISTIVE TOUCH SCREEN CONTROLLER

## **AR1000 Series Resistive Touch Screen Controller**

#### **Special Features:**

- · RoHS Compliant
- · Power-Saving Sleep mode
- Industrial Temperature Range
- Built-in Drift Compensation Algorithm
- 128 Bytes of User EEPROM

#### **Power Requirements:**

- Operating Voltage: 2.5-5.0V ±5%
- Standby Current:
- 5V: 85 uA, typical; 125 uA (maximum)
- 2.5V: 40 uA, typical; 60 uA (maximum)
- Operating "No touch" Current:
- 3.0 mA (typical)
- Operating "Touch" Current:
  - 17 mA, typical, with a touch sensor having  $200\Omega$  layers.
  - Actual current is dependent on the touch sensor used
- AR1011/AR1021 Brown-Out Detection (BOR) set to 2.2V.

## **Touch Modes:**

• Off, Stream, Down, Up and more.

### **Touch Sensor Support:**

- 4-Wire, 5-Wire and 8-Wire Analog Resistive
- Lead-to-Lead Resistance: 50-2,000Ω (typical)
- · Layer-to-Layer Capacitance: 0-0.5 uF
- Touch Sensor Time Constant: 500 us (maximum)

## **Touch Resolution:**

• 10-bit Resolution (maximum)

### **Touch Coordinate Report Rate:**

- 140 Reports Per Second (typical) with a Touch Sensor of 0.02 uF with  $200\Omega$  Layers
- Actual Report Rate is dependent on the Touch Sensor used.

## **Communications:**

- SPI, Slave mode, p/n AR1021
- I<sup>2</sup>C<sup>TM</sup>, Slave mode, p/n, AR1021
- UART, 9600 Baud Rate, p/n AR1011

#### **Table of Contents**

1.0	Device Overview	5
2.0	Basics of Resistive Sensors	7
3.0	Hardware	
4.0	I <sup>2</sup> C Communications	. 17
5.0	SPI Communications	
6.0	UART Communications	. 25
7.0	Touch Reporting Protocol	. 27
8.0	Configuration Registers	
9.0	Commands	
10.0	Application Notes	
11.0	Electrical Specifications	. 51
12.0	Packaging Information	. 53
Appe	ndix A: Revision History	. 63
Appe	ndix B: Device Differences	. 64
The N	licrochip Web Site	. 67
	mer Change Notification Service	
Custo	mer Support	. 67
Read	er Response	. 68

## TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@microchip.com or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

#### **Most Current Data Sheet**

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

#### http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

#### Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <a href="http://www.microchip.com">http://www.microchip.com</a>
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

#### **Customer Notification System**

Register on our web site at www.microchip.com to receive the most current information on all of our products.

## 1.0 DEVICE OVERVIEW

The Microchip mTouch<sup>TM</sup> AR1000 Series Resistive Touch Screen Controller is a complete, easy to integrate, cost-effective and universal touch screen controller chip.

The AR1000 Series has sophisticated proprietary touch screen decoding algorithms to process all touch data, saving the host from the processing overhead. Providing filtering capabilities beyond that of other low-cost devices, the AR1000 delivers reliable, validated, and calibrated touch coordinates.

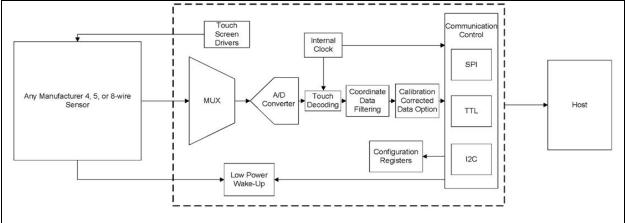
Using the on-board EEPROM, the AR1000 can store and independently apply the calibration to the touch coordinates before sending them to the host. This unique combination of features makes the AR1000 the most resource-efficient touch screen controller for system designs, including embedded system integrations.

## 1.1 Applications

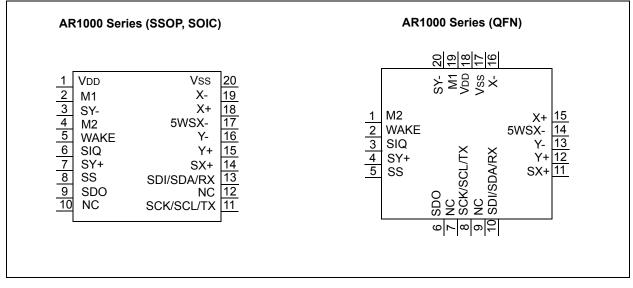
The AR1000 Series is designed for high volume, small form factor touch solutions with quick time to market requirements – including, but not limited to:

- Mobile communication devices
- Personal Digital Assistants (PDA)
- Global Positioning Systems (GPS)
- Touch Screen Monitors
- KIOSK
- · Media Players
- · Portable Instruments
- · Point of Sale Terminals

FIGURE 1-1: BLOCK DIAGRAM







Pin	I				
SSOP, SOIC	QFN	Function	Description/Comments		
1	18	Vdd	Supply Voltage		
2	19	M1 Communication Select			
3	20	SY-	Sense Y- (8-wire). Tie to Vss, if not used.		
4	1	M2	4/8-wire or 5-wire Sensor Selection		
5	2	WAKE	Touch Wake-up/Touch Detection		
6	3	SIQ	LED Drive/SPI Interrupt. No connect, if not used.		
7	4	SY+	Sense Y+ (8-wire). Tie to Vss, if not used.		
8	5	SS	Slave Select (SPI). Tie to Vss, if not used.		
9	6	SDO	SPI Serial Data Output/I <sup>2</sup> C™ Interrupt. Tie to Vss, if UART.		
10	7	NC	No connection. No connect or tie to Vss or VDD.		
11	8	SCK/SCL/TX	SPI/I <sup>2</sup> C™ Serial Clock/UART Transmit		
12	9	NC	No connection. No connect or tie to Vss or VDD.		
13	10	SDI/SDA/RX	I <sup>2</sup> C™ Serial Data/SPI Serial Data Input/UART Receive		
14	11	SX+	Sense X+ (8-wire). Tie to Vss, if not used.		
15	12	Y+	Y+ Drive		
16	13	Y-	Y- Drive		
17	14	5WSX-	5W Sense (5-wire)/Sense X- (8-wire). Tie to Vss, if not used.		
18	15	X+	X+ Drive		
19	16	Х-	X- Drive		
20	17	Vss	Supply Voltage Ground		

## 2.0 BASICS OF RESISTIVE SENSORS

## 2.1 Terminology

<u>ITO</u> (Indium Tin Oxide) is the resistive coating that makes up the active area of the touch sensor. ITO is a transparent semiconductor that is sputtered onto the touch sensor layers.

<u>Flex or Film or Topsheet</u> is the top sensor layer that a user touches. *Flex* refers to the fact that the top layer physically flexes from the pressure of a touch.

<u>Stable or Glass</u> is the bottom sensor layer that interfaces against the display.

<u>Spacer Adhesive</u> is a frame of adhesive that connects the flex and stable layers together around the perimeter of the sensor.

<u>Spacer Dots</u> maintain physical and electrical separation between the flex and stable layers. The dots are typically printed onto the stable layer.

<u>Bus Bars or Silver Frit</u> electrically connect the ITO on the flex and stable layers to the sensor's interface tail. Bus bars are typically screen printed silver ink. They are typically much lower in resistivity than the ITO.

<u>X-Axis</u> is the left and right direction on the touch sensor.

<u>Y-Axis</u> is the top and bottom direction on the touch sensor.

<u>Drive Lines</u> supply a voltage gradient across the sensor.

## 2.2 General

Resistive 4, 5, and 8-wire touch sensors consist of two facing conductive layers, held in physical separation from each other. The force of a touch causes the top layer to deflect and make electrical contact with the bottom layer.

Touch position measurements are made by applying a voltage gradient across a layer or axis of the touch sensor. The touch position voltage for the axis can be measured using the opposing layer.

A comparison of typical sensor constructions is shown below in Table 2-1.

Sensor	Comments	
4-Wire	Less expensive than 5-wire or 8-wire Lower power than 5-wire More linear (without correction) than 5-wire Touch inaccuracies occur from flex layer damage or resistance changes	
5-Wire	Maintains touch accuracy with flex layer damage Inherent nonlinearity often requires touch data correction Touch inaccuracies occur from resistance changes	
8-Wire	More expensive than 4-wire Lower power than 5-wire More linear (without correction) than 5-wire Touch inaccuracies occur from flex layer damaged Maintains touch accuracy with resistance changes	

#### TABLE 2-1:SENSOR COMPARISON

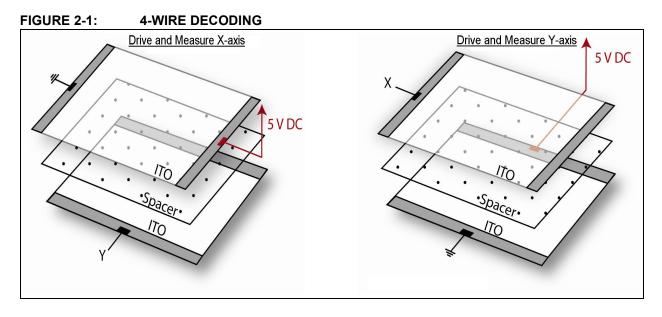
The AR1000 Series Resistive Touch Screen Controllers will work with any manufacturers of analog resistive 4, 5 and 8-wire touch screens. The communications and decoding are included, allowing the user the quickest simplest method of interfacing analog resistive touch screens into their applications.

The AR1000 Series was designed with an understanding of the materials and processes that make up resistive touch screens. The AR1000 Series Touch Controller is not only reliable, but can enhance the reliability and longevity of the resistive touch screen, due to its advanced filtering algorithms and wide range of operation.

### 2.3 4-Wire Sensor

A 4-wire resistive touch sensor consists of a stable and flex layer, electrically separated by spacer dots. The layers are assembled perpendicular to each other. The touch position is determined by first applying a voltage gradient across the flex layer and using the stable layer to measure the flex layer's touch position voltage. The second step is applying a voltage gradient across the stable layer and using the flex layer to measure the stable layer's touch position voltage.

The measured voltage at any position across a driven axis is predictable. A touch moving in the direction of the driven axis will yield a linearly changing voltage. A touch moving perpendicular to the driven axis will yield a relatively unchanging voltage (See Figure 2-1).

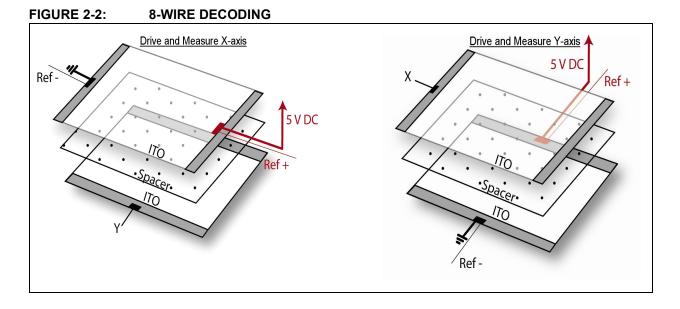


### 2.4 8-Wire Sensor

An 8-wire resistive touch sensor consists of a stable and flex layer, electrically separated by spacer dots. The layers are assembled perpendicular to each other. The touch position is determined by first applying a voltage gradient across the flex layer and using the stable layer to measure the flex layer's touch position voltage. The second step is applying a voltage gradient across the stable layer and using the flex layer to measure the stable layer's touch position voltage.

The measured voltage at any position across a driven axis is predictable. A touch moving in the direction of the driven axis will yield a linearly changing voltage. A touch moving perpendicular to the driven axis will yield a relatively unchanging voltage. The basic decoding of an 8-wire sensor is similar to a 4-wire. The difference is that an 8-wire sensor has four additional interconnects used to reference sensor voltage back to the controller.

A touch system may experience voltage losses due to resistance changes in the bus bars and connection between the controller and sensor. The losses can vary with product use, temperature, and humidity. In a 4-wire sensor, variations in the losses manifest themselves as error or drift in the reported touch location. The four additional sense lines found on 8-wire sensors are added to dynamically reference the voltage to correct for this fluctuation during use (See Figure 2-2).



### 2.5 5-Wire Sensor

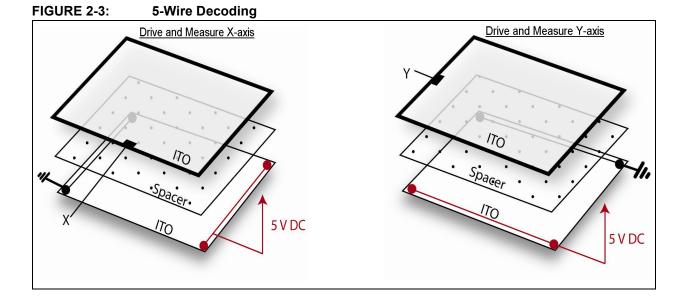
A 5-wire resistive touch sensor consists of a flex and stable layer, electrically separated by spacer dots. The touch position is determined by first applying a voltage gradient across the stable layer in the X-axis direction and using the flex layer to measure the axis touch position voltage. The second step is applying a voltage gradient across the stable layer in the Y-axis direction and using the flex layer to measure the axis touch position voltage.

The voltage is not directly applied to the edges of the active layer, as it is for 4-wire and 8-wire sensors. The voltage is applied to the corners of a 5-wire sensor.

To measure the X-axis, the left edge of the layer is driven with 0V (ground), using connections to the upper left and lower left sensor corners. The right edge is driven with +5 VDC, using connections to the upper right and lower right sensor corners.

To measure the Y-axis, the top edge of the layer is driven with 0V (ground), using connections to the upper left and upper right sensor corners. The bottom edge is driven with +5 VDC, using connections to the lower left and lower right sensor corners.

The measured voltage at any position across a driven axis is predictable. A touch moving in the direction of the driven axis will yield a linearly changing voltage. A touch moving perpendicular to the driven axis will yield a relatively unchanging voltage (See Figure 2-3).



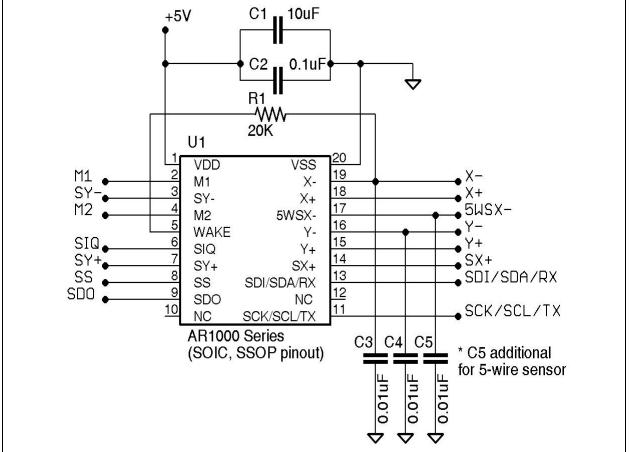
## 3.0 HARDWARE

#### 3.1 Main Schematic

A main application schematic for the SOIC/SSOP package pinout is shown in Figure 3-1.

See Figure 1-2 for the QFN package pinout.





### 3.2 4, 5, 8-Wire Sensor Selection

The desired sensor type of 4/8-wire or 5-wire is hardware selectable using pin M2.

## TABLE 3-1:4/8-WIRE vs. 5-WIRESELECTION

Туре	M2 pin
4/8-wire	Vss
5-wire	Vdd

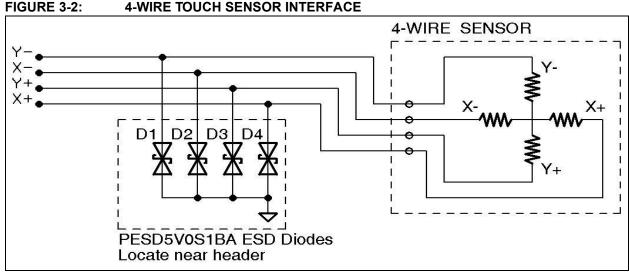
If 4/8-wire has been hardware-selected, then the choice of 4-wire or 8-wire is software-selectable via the TouchOptions Configuration register.

When 4/8-wire is hardware-selected, the controller defaults to 4-wire operation. If 8-wire operation is desired, then the TouchOptions Configuration register must be changed.

#### 3.3 4-Wire Touch Sensor Interface

Sensor tail pinouts can vary by manufacturer and part number. Ensure that both sensor tail pins for one sensor axis (layer) are connected to the controller's X-/X+ pins and the tail pins for the other sensor axis (layer) are connected to the controller's Y-/Y+ pins. The controller's X-/X+ and Y-/Y+ pin pairs do not need to connect to a specific sensor axis. The orientation of controller pins X- and X+ to the two sides of a given sensor axis is not important. Likewise, the orientation of controller pins Y- and Y+ to the two sides of the other sensor axis is not important.

Connections to a 4-wire touch sensor are as follows (See Figure 3-2).



Tie unused controller pins 5WSX-, SX+, SY-, and SY+ to Vss.

See Section 3.8 "ESD Considerations" and Section 3.9 "Noise Considerations" for important information regarding the capacitance of the controller schematic hardware.

### 3.4 5-Wire Touch Sensor Interface

Sensor tail pinouts can vary by manufacturer and part number. Ensure sensor tail pins for one pair of diagonally related sensor corners are connected to the controller's X-/X+ pins and the tail pins for the other pair of diagonally related corners are connected to the controller's Y-/Y+ pins.

The controller's X-/X+ and Y-/Y+ pin pairs do not need to connect to a specific sensor axis. The orientation of controller pins X- and X+ to the two selected diagonal sensor corners is not important.

Likewise, the orientation of controller pins Y- and Y+ to the other two selected diagonal sensor corners is not important. The sensor tail pin connected to its top layer must be connected to the controller's 5WSX- pin.

Connections to a 5-wire touch sensor are shown in Figure 3-3 below.

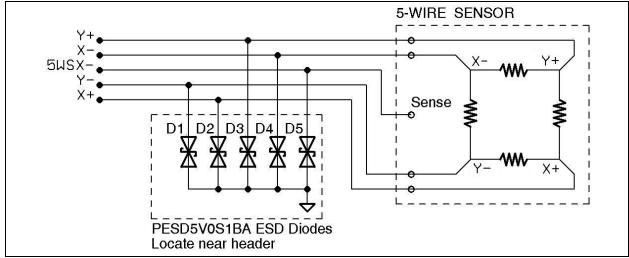


FIGURE 3-3: 5-WIRE TOUCH SENSOR INTERFACE

Tie unused controller pins SX+, SY-, and SY+ to Vss.

See **"Section 3.8 "ESD Considerations"** and **Section 3.9 "Noise Considerations"** for important information regarding the capacitance of the controller schematic hardware.

### 3.5 8-Wire Touch Sensor Interface

Sensor tail pinouts can vary by manufacturer and part number. Ensure both sensor tail pins for one sensor axis (layer) are connected to the controller's X-/X+ pins and the tail pins for the other sensor axis (layer) are connected to the controller's Y-/Y+ pins.

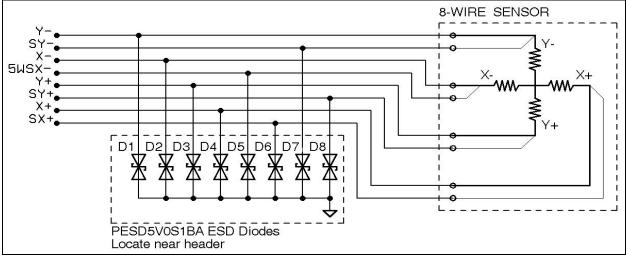
The controller's X-/X+ and Y-/Y+ pin pairs do not need to connect to a specific sensor axis. The orientation of controller pins X- and X+ to the two sides of a given sensor axis is not important. Likewise, the orientation of controller pins Y- and Y+ to the two sides of the other sensor axis is not important.

The 8-wire sensor differs from a 4-wire sensor in that each edge of an 8-wire sensor has a secondary connection brought to the sensor's tail. These secondary connections are referred to as "sense" lines. The controller pins associated with the sense line for an 8-wire sensor contain an 'S' prefix in their respective names. For example, the SY- pin is the sense line connection associated with the main Y- pin connection. Consult with the sensor manufacturer's specification to determine which member of each edge connected pair is the special 8-wire "sense" connection. Incorrectly connecting the sense and excite lines to the controller will adversely affect performance.

The controller requires that the main and "sense" tail pin pairs for sensor edges be connected to controller pin pairs as follows:

- · Y- and SY-
- Y+ and SY+
- X- and 5WSX-
- X+ and SX+

Connections to a 8-wire touch sensor are shown in Figure 3-4 below.



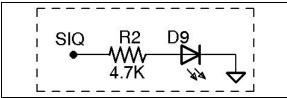
See Section 3.8 "ESD Considerations" and Section 3.9 "Noise Considerations" for important information regarding the capacitance of the controller schematic hardware.

#### FIGURE 3-4: 8-WIRE TOUCH SENSOR INTERFACE

#### 3.6 Status LED

The LED and associated resistor are optional.

#### FIGURE 3-5:



The LED serves as a status indicator that the controller is functioning. It will slow flash when the controller is running with no touch in progress. It will flicker quickly (mid-level on) when a touch is in progress.

If the LED is used with SPI communication, then the LED will be off with no touch and flicker quickly (mid-level on) when a touch is in progress.

Note:	If the SIQ pin is not used, it must be left as
	a No Connect and NOT tied to circuit VDD or
	Vss.

### 3.7 WAKE Pin

The AR1000's WAKE pin is described as "Touch Wake-Up/Touch Detection". It serves the following three roles in the controller's functionality:

- Wake-up from touch
- Touch detection
- Measure sensor capacitance

The application circuit shows a 20 K $\Omega$  resistor connected between the WAKE pin and the X- pin on the controller chip. The resistor is required for product operation, based on all three of the above roles.

### 3.8 ESD Considerations

ESD protection is shown on the 4-wire, 5-wire, and 8-wire interface applications schematics.

The capacitance of alternate ESD diodes may adversely affect touch performance. A lower capacitance is better. The PESD5V0S1BA parts shown in the reference design have a typical capacitance of 35 pF. Test to ensure that selected ESD protection does not degrade touch performance.

ESD protection is shown in the reference design, but acceptable protection is dependent on your specific application. Ensure your ESD solution meets your design requirements.

## 3.9 Noise Considerations

Touch sensor filtering capacitors are included in the reference design.

Warning: Changing the value of the capacitors may adversely affect performance of the touch system.

NOTES:

## 4.0 $I^2 C^{TM}$ COMMUNICATIONS

The AR1021 is an  $l^2C$  slave device with a 7-bit address of 0x4D, supporting up to 400 kHz bit rate.

A master (host) device interfaces with the AR1021.

## 4.1 I<sup>2</sup>C Hardware Interface

A summary of the hardware interface pins is shown below in Table 4-1.

#### TABLE 4-1: I<sup>2</sup>C HARDWARE INTERFACE

AR1021 Pin	Description				
M1	Connect to Vss to select I <sup>2</sup> C <sup>™</sup> communications				
SCL	Serial Clock to master I <sup>2</sup> C				
SDA	Serial Data to master I <sup>2</sup> C				
SDO	Data ready interrupt output to master				

#### M1 Pin

• The M1 pin must be connected to Vss to configure the AR1021 for I<sup>2</sup>C communications.

#### SCL Pin

- The SCL (Serial Clock) pin is electrically open-drain and requires a pull-up resistor, typically 2.2 KΩ to 10 KΩ, from SCL to VDD.
- · SCL Idle state is high.

#### SDA Pin

- The SDA (Serial Data) pin is electrically open-drain and requires a pull-up resistor, typically 2.2KΩ to 10KΩ, from SDA to VDD.
- SDA Idle state is high.
- Master write data is latched in on SCL rising edges.
- Master read data is latched out on SCL falling edges to ensure it is valid during the subsequent SCL high time.

#### SDO Pin

- The SDO pin is a driven output interrupt to the master.
- SDO Idle state is low.
- SDO will be asserted high when the AR1021 has data ready (touch report or command response) for the master to read.

#### 4.2 I<sup>2</sup>C Pin Voltage Level Characteristics

#### TABLE 4-2: I<sup>2</sup>C PIN VOLTAGE LEVEL CHARACTERISTICS

Function	Pin	Input	Output
SCL/SCK	SCL/SCK/TX	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>ViH</b> ≤ Vdd	_
SDO	SDO	_	Vss ≤ VoL <sup>(1)</sup> ≤ $(1.2V - 0.15^*VDD)^{(2)}$ $(1.25^*VDD - 2.25V)^{(3)} ≤ VOH^{(1)} ≤ VDD$
SDA	SDI/SDA/RX	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>Vih</b> ≤ Vdd	Open-drain

**Note 1:** These parameters are characterized but not tested.

2: At 10 mA.

**3:** At –4 mA.

#### 4.3 Addressing

The AR1021's device ID 7-bit address is: 0x4D (Ob1001101)

#### TABLE 4-3:I<sup>2</sup>C DEVICE ID ADDRESS

	Device ID Address, 7-bit									
A7 A6 A5 A4 A3 A2 A1										
1	0	0	1	1	0	1				

## TABLE 4-4:I<sup>2</sup>C DEVICE WRITE ID<br/>ADDRESS

A7	A6	A5	A4	A3	A2	A1	A0	
1	0	0	1	1	0	1	0	0x9A

#### TABLE 4-5: I<sup>2</sup>C DEVICE READ ID ADDRESS

A7	A6	A5	A4	A3	A2	A1	A0	
1	0	0	1	1	0	1	1	0x9B

### 4.4 Master Read Bit Timing

Master read is to receive touch reports and command responses from the AR1021.

- Address bits are latched into the AR1021 on the rising edges of SCL.
- Data bits are latched out of the AR1021 on the rising edges of SCL.
- ACK is presented (by AR1021 for address, by master for data) on the ninth clock.
- The master must monitor the SCL pin prior to asserting another clock pulse, as the AR1021 may be holding off the master by stretching the clock.

### FIGURE 4-1: I<sup>2</sup>C MASTER READ BIT TIMING DIAGRAM

		Address	R/W ACK	Data	ACK	Data	ACK
SDA		7 <u>\A6\A5\A4\A3\A2</u> +	XA1/1 /				
SCL	 ' <b>s</b> _'/1	 \_/2\_/3\_/4\_/5\_/6'		 /1_/2\_/3\_/4\_/5\_/6\_	/7\_/8\_/9\	1_2_3_4_5_6_7_8	_9 <mark>₽_</mark> _
	Start Bit	Address Bits Latched In	SCL maybe stretc by AR1000	hed Data Bits Valid Out	SCL maybe sti by AR1000	retched Data Bits Valid Out	Stop Bit
Stens				4	AR1021 co	mnares the received add	ress to its

#### Steps

- 1. SCL and SDA lines are Idle high.
- Master presents "Start" bit to the AR1021 by taking SDA high-to-low, followed by taking SCL high-to-low.
- Master presents 7-bit Address, followed by a R/W = 1 (Read mode) bit to the AR1021 on SDA, at the rising edge of eight master clock (SCL) cycles.
- AR1021 compares the received address to its device ID. If they match, the AR1021 acknowledges (ACK) the master sent address by presenting a low on SDA, followed by a low-high-low on SCL.
- 5. Master monitors SCL, as the AR1021 may be "clock stretching", holding SCL low to indicate that the master should wait.

- Master receives eight data bits (MSb first) presented on SDA by the AR1021, at eight sequential master clock (SCL) cycles. The data is latched out on SCL falling edges to ensure it is valid during the subsequent SCL high time.
- 7. If data transfer is not complete, then:
  - Master acknowledges (ACK) reception of the eight data bits by presenting a low on SDA, followed by a low-high-low on SCL.
- Go to step 5.
- 8. If data transfer is complete, then:
  - Master acknowledges (ACK) reception of the eight data bits and a completed data transfer by presenting a high on SDA, followed by a low-high-low on SCL.

 Master presents a "Stop" bit to the AR1021 by taking SCL low-high, followed by taking SDA low-to-high.

### 4.5 Master Write Bit Timing

Master write is to send supported commands to the AR1021.

- Address bits are latched into the AR1021 on the rising edges of SCL.
- Data bits are latched into the AR1021 on the rising edges of SCL.
- ACK is presented by AR1021 on the ninth clock.
- The master must monitor the SCL pin prior to asserting another clock pulse, as the AR1021 may be holding off the master by stretching the clock.

#### FIGURE 4-2: I<sup>2</sup>C MASTER WRITE BIT TIMING DIAGRAM

		Address	R/W ACK	Data	ACK	Data	ACK
SDA		(A6)(A5)(A4)(A3)(A2	XA1 0	/D7XD6XD5XD4XD3XD2>		<u>/D7/D6/D5/D4/D3/D2/D1/D0</u>	
SCL	 's_'∕1	† J2\_/3\_/4\_/5\_/6\			∫7\_/8\_/9\	↓ 」1、」2、3、4、5、6、7、8、	J9\[₽]
	Start Bit	Address Bits Latched In	SCL maybe stre by AR1000	tched Data Bits Latched In	SCL maybe stre by AR1000	tched Data Bits Latched In	Stop Bit

#### Steps

- 1. SCL and SDA lines are Idle high.
- Master presents "Start" bit to the AR1021 by taking SDA high-to-low, followed by taking SCL high-to-low.
- Master presents 7-bit Address, followed by a R/W = 0 (Write mode) bit to the AR1021 on SDA, at the rising edge of eight master clock (SCL) cycles.
- AR1021 compares the received address to its device ID. If they match, the AR1021 acknowledges (ACK) the master sent address by presenting a low on SDA, followed by a low-high-low on SCL.
- 5. Master monitors SCL, as the AR1021 may be "clock stretching", holding SCL low to indicate the master should wait.
- 6. Master presents eight data bits (MSb first) to the AR1021 on SDA, at the rising edge of eight master clock (SCL) cycles.
- AR1021 acknowledges (ACK) receipt of the eight data bits by presenting a low on SDA, followed by a low-high-low on SCL.
- 8. If data transfer is not complete, then go to step 5.
- 9. Master presents a "Stop" bit to the AR1021 by taking SCL low-high, followed by taking SDA low-to-high.

#### 4.6 Clock Stretching

The master normally controls the clock line SCL. Clock stretching is when the slave device holds the SCL line low, indicating to the master that it is not ready to continue the communications.

During communications, the AR1021 may hold off the master by stretching the clock with a low on SCL.

The master must monitor the slave SCL pin to ensure the AR1021 is not holding it low, prior to asserting another clock pulse for transmitting or receiving.

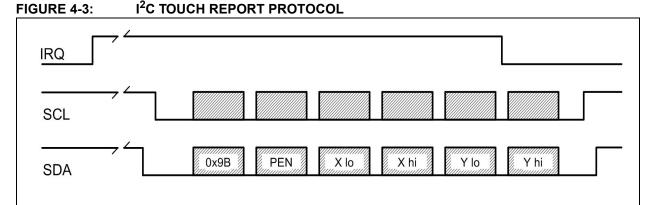
## 4.7 AR1020 Write Conditions

The AR1020 part does not implement clock stretching on write conditions.

A 50 us delay is needed before the Stop bit, when clocking a command to the AR1020.

#### 4.8 Touch Report Protocol

Touch coordinates, when available, are provided to the master by the AR1021 in the following protocol (See Figure 4-3).



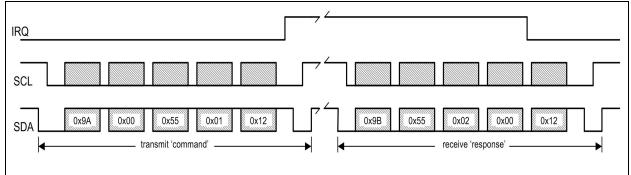
Note that the IRQ signal shown above occurs on the SDO pin of the AR1021.

#### 4.9 Command Protocol

The master issues supported commands to the AR1021 in the following protocol.

Below is an example of the ENABLE\_TOUCH command (see Figure 4-4).

### FIGURE 4-4: I<sup>2</sup>C COMMAND PROTOCOL



Note that the IRQ shown above occurs on the SDO pin.

- 0x9A AR1021 Device ID address
- Ox00 Protocol command byte (send 0x00 for the protocol command register)
- 0x55 Header
- 0x01 Data size
- 0x12 Command

#### 4.10 Sleep State

Pending communications are not maintained through a sleep/wake cycle.

If the SDO pin is asserted for a pending touch report or command response, and the AR1021 enters a Sleep state, prior to the master performing a read on the data, then the data is lost.

## 5.0 SPI COMMUNICATIONS

SPI operates in Slave mode with an Idle low SCK and data transmitted on the SCK falling edge.

### 5.1 SPI Hardware Interface

A summary of the hardware interface pins is shown below in Table 5-1.

#### TABLE 5-1: SPI HARDWARE INTERFACE

AR1021 Pin	Description				
M1	Connect to VDD to select SPI communications				
SDI	Serial data sent from master				
SCK	Serial clock to master				
SDO	Serial data to master SPI				
SIQ	Interrupt output to master (optional)				
SS	Slave Select (optional)				

#### SCK Pin

- The AR1021 controller's SCL/SCK/TX pin receives Serial Clock (SCK), controlled by the host.
- The Idle state of the SCK should be low.
- Data is transmitted on the falling edge of SCK.

#### SDI Pin

• The AR1021 controller's SDI/SDA/RX pin reads Serial Data Input (SDI), sent by the host.

#### SDO Pin

• The AR1021 controller's SDO pin presents Serial Data Output (SDO) to the host.

#### SIQ Pin

- The AR1021 controller's SIQ pin provides an optional interrupt output from the controller to the host.
- The SIQ pin is asserted high when the controller has data available (a touch report or a command response) for the host.
- The SIQ pin is deasserted after the host clocks out the first byte of the data packet.

Note: The AR1000 Development kit PICkit<sup>™</sup> Serial Pin 1 is designated for the SIQ interrupt pin after the firmware updated is executed for the PICkit.

#### SS Pin

• The AR1021 controller's SS pin provides optional "slave select" functionality.

SS Pin Level	AR1021 Select
Vss	Active
Vdd	Inactive

In the 'inactive' state, the controller's SDO pin presents a high-impedance in order to prevent bus contention with another device on the SPI bus.

#### 5.2 SPI Pin Voltage Level Characteristics

#### TABLE 5-2: SPI PIN VOLTAGE CHARACTERISTICS

Operating Vo	<b>Itage:</b> 2.5V ≤ VDD	≤ 5.25V	
Function	Pin	Input	Output
SCK	SCL/SCK/TX	Vss ≤ <b>ViL</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>ViH</b> ≤ Vdd	—
SDI	SDI/SDA/RX	Vss ≤ <b>ViL</b> ≤ 0.2*VDD 0.8*VDD ≤ <b>VIH</b> ≤ VDD	_
SDO	SDO	_	Vss ≤ VoL <sup>(1)</sup> ≤ $(1.2V - 0.15*V_{DD})^{(2)}$ $(1.25*V_{DD} - 2.25V)^{(3)} ≤ VoH^{(1)} ≤ V_{DD}$
SIQ	SIQ	—	$V_{SS} \le VoL^{(1)} \le (1.2V - 0.15^*V_{DD})^{(2)}$ $(1.25^*V_{DD} - 2.25V)^{(3)} \le VoH^{(1)} \le V_{DD}$
SS	SS	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>Vih</b> ≤ Vdd	

Note 1: These parameters are characterized but not tested.

2: At 10 mA.

3: At -4 mA.

## 5.3 Data Flow

SPI data is transferred by the host clocking the AR1021 controller's Serial Clock (SCK) pin.

Each host driven clock cycle simultaneously shifts a bit of data into and out from the AR1021 controller:

- Out from the AR1021 controller's Serial Data Out (SDO) line.
- Into the AR1021 controller's Serial Data In (SDI) line.

The data is shifted Most Significant bit (MSb) first.

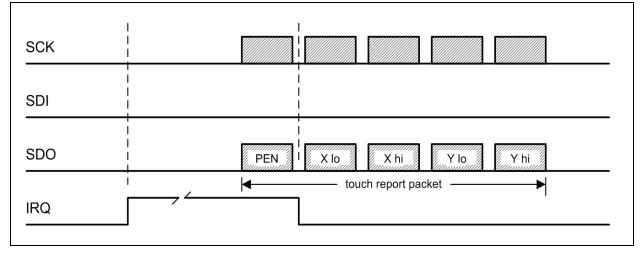
If the host clocks data out from the AR1021 controller when no valid data is available, then a byte value of 0x4d will be presented by the controller.

## 5.4 Touch Report Protocol

The AR1021 controller's touch reporting is interrupt driven:

- The AR1021 controller asserts the SIQ interrupt pin high when it has a touch report ready.
- The host clocks out the bytes of the touch report packet from the AR1021 controller.
- The AR1021 controller clears the SIQ interrupt pin low, after the first byte of the touch report packet has been clocked out by the host.

The communication protocol for the AR1021 controller reporting touches to the host as shown below in Figure 5-1.



#### FIGURE 5-1: SPI TOUCH REPORT PROTOCOL

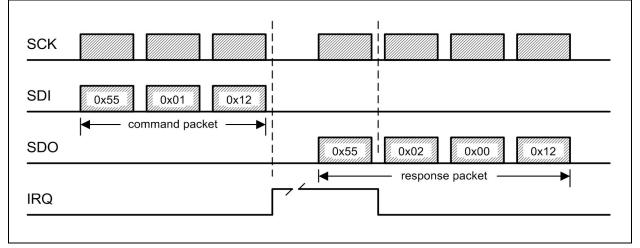
## 5.5 Command Protocol

The AR1021 controller receives commands from the host as follows:

- The host clocks the bytes of a command to the AR1021 controller.
- The AR1021 controller asserts the SIQ interrupt pin high when it is ready with a response to the command sent by the host.
- The host clocks out the bytes of the command response from the AR1021 controller.
- The AR1021 controller clears the SIQ interrupt pin low, after the first byte of the command response has been clocked out by the host.

The communication protocol for the host sending the ENABLE\_TOUCH command to the AR1021 controller is shown below in Figure 5-2.

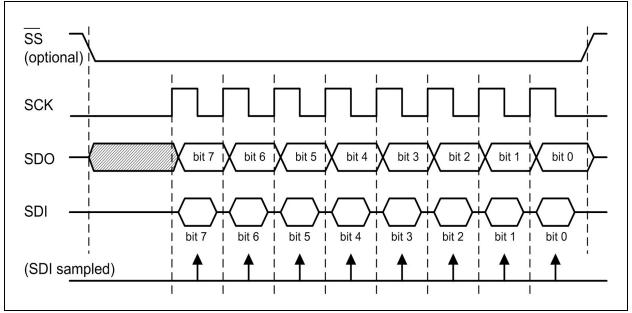
## FIGURE 5-2: SPI TIMING DIAGRAM – COMMAND PROTOCOL (ENABLE\_TOUCH)



### 5.6 SPI Bit Timing – General

General timing waveforms are shown below in Figure 5-3.

## FIGURE 5-3: SPI GENERAL BIT TIMING WAVEFORM



### 5.7 Timing – Bit Details

#### 5.7.1 BIT RATE

The SPI standard does not specify a maximum data rate for the serial bus. In general, SPI data rates can be in MHz. Peripherals devices, such as the AR1021 controller, specify their own unique maximum SPI data rates.

The maximum SPI bit rate for the AR1021 controller is  ${\sim}900~\text{kHz}.$ 

Characterization has been performed at bit rates of ~39 kHz and ~156 kHz.

#### SS -10 <del>-</del> SCK 13 2 Clock for LSb's of SDO and SDI 16 MSb LSb SDO bit 6 19 17, 18 SDI LSb In MSb In bit 6 5 '14'

#### FIGURE 5-4: SPI BIT TIMING – DETAIL

#### 5.7.2 INTER-BYTE DELAY

The AR1021 controller requires an inter-byte delay of  $\sim$ 50 us. This means the host should wait  $\sim$ 50 us between the end of clocking a given byte and the start of clocking the next byte.

#### 5.7.3 BIT TIMING – DETAIL

Characterized timing details are shown below, in Figure 5-4.

#### TABLE 5-3:SPI BIT TIMING MIN. AND MAX. VALUES

Parameter Number <sup>(1)</sup>	Parameter Description	Min.	Max.	Units
10	SS↓ (select) to SCK↑ (initial)	500	—	ns
11	SCK high	550	—	ns
12	SCK low	550	—	ns
13 SCK↓ (last) to SS↑ (deselect)		800	—	ns
14	14 SDI setup before SCK↓		—	ns
15	SDI hold after SCK↓	100	—	ns
16	SDO valid after SCK↓	—	150	ns
17	17 SDO↑ rise		50	ns
18 SDO↓ fall		—	50	ns
19 SS↑ (deselect) to SDO High-z		10	50	ns

Note 1: Parameters are characterized, but not tested.

## 6.0 UART COMMUNICATIONS

### TABLE 6-1: UART HARDWARE INTERFACE

AR1011 Pin	Description				
M1	M1 Connect M1 to VDD to select UART communications				
TX	Transmit to host				
RX	Receive from host				
SDO Connect SDO to Vss					

UART communication is fixed at 9600 baud rate, 8N1 format.

Sleep mode will cause the TX line to drop low, which may appear as a 0x00 byte sent from the controller.

NOTES:

## 7.0 TOUCH REPORTING PROTOCOL

Touch coordinates are sent from the controller to the host system in a 5-byte data packet, which contains the X-axis coordinate, Y-axis coordinate, and a "Pen-Up/ Down" touch status.

The range for X-axis and Y-axis coordinates is from 0-4095 (12-bit). The realized resolution is 1024, and bits X1:X0 and Y1:Y0 are zeros.

It is recommended that applications be developed to read the 12-bit coordinates from the packet and use them in a 12-bit format. This enhances the application robustness, as it will work with either 10 or 12 bits of coordinate information.

The touch coordinate reporting protocol is shown below in Table 7-1.

Byte #	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	1	R	R	R	R	R	R	Р
2	0	X6	X65	X4	X3	X2	X1	X0
3	0	0	0	X11	X10	X9	X8	X7
4	0	Y6	Y5	Y4	Y3	Y2	Y1	Y0
5	0	0	0	Y11	Y10	Y9	Y8	Y7

## TABLE 7-1: TOUCH COORDINATE REPORTING PROTOCOL

where:

- P: 0 Pen Up, 1 Pen Down
- R: Reserved

• X11-X0: X-axis coordinate

• Y11-Y0: Y-axis coordinate

NOTES:

## 8.0 CONFIGURATION REGISTERS

The Configuration registers allow application specific customization of the controller. The default values have been optimized for most applications and are automatically used, unless you choose to change them.

Unique sensors and/or product applications may benefit from adjustment of Configuration registers.

**Note:** Although most registers can be configured for a value ranging from 0 to 255, using a value outside the specified range for the specific register may negatively impact performance.

### 8.1 Restoring Default Parameters

#### • AR1010/AR1020

The factory default settings for the Configuration registers can be recovered by writing a value of 0xFF to address 0x00 of the EEPROM, then cycling power.

• AR1011/AR1021

The factory default settings for the Configuration registers can be recovered by writing a value of 0xFF to addresses 0x01 and 0x29 of the EEPROM, then cycling power.

Register Name	Address Offset	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	AR1010/ AR1020 Default	AR1011/ AR1021 Default
<special use=""></special>	0x00	<non-< td=""><td>Config</td><td>urable</td><td>&gt;</td><td></td><td></td><td></td><td></td><td>0x58</td><td>0x58</td></non-<>	Config	urable	>					0x58	0x58
<special use=""></special>	0x01	<non-< td=""><td>Config</td><td>urable</td><td>&gt;</td><td></td><td></td><td></td><td></td><td>0x01</td><td>0x01</td></non-<>	Config	urable	>					0x01	0x01
TouchThreshold	0x02	Value	of: 0-2	255						0xC5	0xC5
SensitivityFilter	0x03	Value	of: 0-2	255						0x04	0x04
SamplingFast	0x04	Value	of: 1,	2, 4, 8	, 16, 3	2, 64, 1	28			0x04	0x04
SamplingSlow	0x05	Value	of: 1,	2, 4, 8	, 16, 3	2, 64, 1	28			0x10	0x10
AccuracyFilterFast	0x06	Value	of: 1-8	3						0x02	0x04
AccuracyFilterSlow	0x07	Value	of: 1-8	3						0x08	0x08
SpeedThreshold	0x08	Value	of: 0-2	255						0x04	0x04
<special use=""></special>	0x09	<non-< td=""><td>Config</td><td>urable</td><td>&gt;</td><td></td><td></td><td></td><td></td><td>0x23</td><td>0x23</td></non-<>	Config	urable	>					0x23	0x23
SleepDelay	0x0A	Value	of: 0-2	255						0x64	0x64
PenUpDelay	0x0B	Value	of: 0-2	255						0x80	0x80
TouchMode	0x0C	PD2	PD1	PD0	PM1	PM0	PU2	PU1	PU0	0xB1	0xB1
TouchOptions	0x0D	_	_	_	_	_	_	48W	CCE	0x00	0x00
CalibrationInset	0x0E									0x19	0x19
PenStateReportDelay	0x0F	Value	Value of: 0-40							0xC8	0xC8
<special use=""></special>	0x10	Value	Value of: 0-255							0x03	0x03
TouchReportDelay	0x11	<non-< td=""><td>Config</td><td>urable</td><td>&gt;</td><td></td><td></td><td></td><td></td><td>0x00</td><td>0x00</td></non-<>	Config	urable	>					0x00	0x00
<special use=""></special>	0x12	Value	of: 0-2	255						0x00	0x00

### TABLE 8-1:CONFIGURATION REGISTERS

Configuration registers are defined as an Offset value from the Start address for the register group.

To read or write to a register, do the following:

- Issue the REGISTER\_START\_ADDRESS\_REQUEST command to obtain the Start address for the register group.
- Calculate the desired register's absolute address by adding the register's Offset value to Start address for the register group.

• Issue the REGISTER\_READ or REGISTER\_WRITE command, using the calculated register's absolute address.

**Warning:** Use of invalid register values will yield unpredictable results.

### 8.2 Register Descriptions

## 8.2.1 TouchThreshold Register (OFFSET 0x02)

The TouchThreshold register sets the threshold for a touch condition to be detected as a touch. A touch is detected if it is below the TouchThreshold setting. Too small of a value might prevent the controller from accepting a real touch, while too large of a value might allow the controller to accept very light or false touch conditions. Valid values are as follows:

 $0 \leq \text{TouchThreshold} \leq 255$ 

## 8.2.2 SensitivityFilter Register (OFFSET 0x03)

The SensitivityFilter register sets the level of touch sensitivity. A higher value is more sensitive to a touch (accepts a lighter touch), but may exhibit a less stable touch position. A lower value is less sensitive to a touch (requires a harder touch), but will provide a more stable touch position. Valid values are as follows:

 $0 \leq \text{SensitivityFilter} \leq 10$ 

## 8.2.3 SamplingFast Register (OFFSET 0x04)

The SamplingFast register sets the level of touch measurement sample averaging, when touch movement is determined to be fast. See the SpeedThreshold register for information on the touch movement threshold. A lower value will provide for a higher touch coordinate reporting rate when touch movement is fast, but may exhibit more high-frequency random noise error in the touch position. A higher value will reduce the touch coordinate reporting rate when touch movement is fast, but will reduce high-frequency random noise error in the touch position. Valid values are as follows:

SamplingFast: <1, 4, 8, 16, 32, 64, 128>

Recommended Values: <4, 8, 16>

Higher values may improve accuracy with some sensors.

## 8.2.4 SamplingSlow Register (OFFSET 0x05)

The SamplingSlow register sets the level of touch measurement sample averaging, when touch movement is slow. See the SpeedThreshold register for information on the touch movement threshold. A lower value will increase the touch coordinate reporting rate when the touch motion is slow, but may exhibit a less stable more jittery touch position. A higher value will decrease the touch coordinate reporting rate when the touch motion is slow, but will provide a more stable touch position. Valid values are as follows:

SamplingSlow: 1, 2, 4, 8, 16, 32, 64, 128

## 8.2.5 AccuracyFilterFast Register (OFFSET 0x06)

The AccuracyFilterFast register sets the level of an accuracy enhancement filter, used when the touch movement is fast. See the SpeedThreshold register for information on the touch movement threshold. A lower value will provide better touch coordinate resolution when the touch motion is fast, but may exhibit more low-frequency noise error in the touch position. A higher value will reduce touch coordinate resolution when the touch motion is fast, but will reduce low-frequency random noise error in the touch position. Valid values are as follows:

 $1 \leq AccuracyFilterFast \leq 8$ 

Higher values may improve accuracy with some sensors.

#### 8.2.6 AccuracyFilterSlow Register (OFFSET 0x07)

The AccuracyFilterSlow register sets the level of an accuracy enhancement filter, used when the touch movement is slow. See the SpeedThreshold register for information on the touch movement threshold. A lower value will provide better touch coordinate resolution when the touch motion is slow, but may exhibit more low-frequency noise error in the touch position. A higher value will reduce touch coordinate resolution when the touch motion is slow, but will reduce low-frequency random noise error in the touch position. Valid values are as follows:

 $1 \leq AccuracyFilterSlow \leq 8$ 

## 8.2.7 SpeedThreshold Register (OFFSET 0x08)

The SpeedThreshold register sets the threshold for touch movement to be considered as slow or fast. A lower value reduces the touch movement speed that will be considered as fast. A higher value increases the touch movement speed that will be considered as fast. Valid values are as follows:

 $0 \leq SpeedThreshhold \leq 255$ 

#### 8.2.8 SleepDelay Register (OFFSET 0x0A)

The SleepDelay register sets the time duration with no touch or command activity that will cause the controller to enter a low-power Sleep mode. Valid values are as follows:

 $0 \leq \text{SleepDelay} \leq 255$ 

Sleep Delay Time = SleepDelay \* 100 ms; when Sleep-Delay > 0

A value of zero disables the Sleep mode, such that the controller will never enter low-power Sleep mode.

A touch event will wake the controller from low-power Sleep mode and start sending touch reports. Communications sent to the controller will wake it from the lowpower Sleep mode and initiate action to the command.

## 8.2.9 PenUpDelay Register (OFFSET 0x0B)

The PenUpDelay register sets the duration of a pen-up event that the controller will allow, without sending a pen-up report for the event. The delay time is started upon detecting a pen-up condition.

If a pen down is reestablished before the delay time expires, then pen-down reports will continue without a pen up being sent. This effectively debounces a touch event in process.

A lower value will make the controller more responsive to pen ups, but will cause more touch drop outs with a lighter touch. A higher value will make the controller less responsive to pen ups, but will reduce the number of touch drop outs with a lighter touch. Valid values are as follows:

 $0 \le \text{PenUpDelay} \le 255$ 

Pen-up Delay Time ≈ PenUpDelay \* 240 µs

#### 8.2.10 TouchMode Register (OFFSET 0x0C)

The TouchMode register configures the action taken for various touch states.

There are three states of touch for the controller's touch reporting action which can be independently controlled. Touch States:

1. Pen Down (initial touch)

User defined 0-3 touch reports, with selectable pen states.

2. Pen Movement (touch movement after initial touch)

User defined no-touch reports or streaming touch reports, with selectable pen states.

3. Pen Up (touch release)

User defined 0-3 touch reports, with selectable pen states.

Every touch report includes a "P" (Pen) bit that indicates the pen state.

- Pen Down: P = 1
- Pen Up: P = 0

## **AR1000 SERIES RESISTIVE TOUCH SCREEN CONTROLLER**

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
PD2	PD1	PD0	PM1	PM0	PU2	PU1	PU0
bit 7							bit (
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimplen	nented bit, read	d as '0'	
bit 7-5	000 = No toud 001 = Touch r 010 = Touch r 011 = Touch r 100 = Touch r	ch report report with P= report with P= report with P= report with P=	) 1 1, then touch 0, then touch	report with P=0 report with P=1 report with P=1		port with P=0	
bit 4-3		n Movement S n report port with P=0		on taken upon p	en movement).		
bit 2-0	PU<2:0>: Per 000 = No toud 001 = Touch r 010 = Touch r 011 = Touch r 100 = Touch r	n-Up State bits ch report report with P= report with P= report with P= report with P=	1 1, then touch 0, then touch	report with P=0 report with P=1 report with P=1	, then touch rep	port with P=0	
A couple of t	ypical setup exarr s:	ples for the To	ouchMode				
by reportin the touch, t release. To	en down P=1 on i g a stream of pen followed by a final ouchMode = 0b01 en up P=0 then a	downs P=1 d pen up P=0 o .010001 = 0x8	uring n touch 51				

initial touch, followed by reporting a stream of pen downs P=1 during the touch, followed by a final pen up P=0 on touch release. TouchMode = 0b10110001 **= 0xB1** 

## 8.2.11 TouchOptions Register (OFFSET 0x0D)

The TouchOptions register contains various "touch" related option bits.

#### **REGISTER 8-2:** TouchOptions **REGISTER**

U-0	U-0	U-0	U-0	U-0	U-0	R/W	R/W
—	—	—	—	—	—	48W	CCE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	

- bit 7-2 Unimplemented: Read as '0'
- bit 1
   48W: 4-Wire or 8-Wire Sensor Selection bit

   1 = Selects 8-wire Sensor Operating mode

   0 = Selects 4-wire Sensor Operating mode

   bit 0
   CCE: Calibrated Coordinates Enable bit

   1 = Enables calibrated coordinates, if the controller has been calibrated
  - 0 = Disables calibrated coordinates
- Note: A 4-wire touch sensor will not work if the 48W Configuration bit is incorrectly defined as 1, which selects 8-wire.
   An 8-wire touch sensor will provide basic operation if the 48W Configuration bit is incorrectly defined as 0, which selects 4-wire. However, the benefit of the 8-wire sensor will only be realized if the 48W Configuration bit is correctly defined as 1, selecting 8-wire.

## 8.2.12 CalibrationInset Register (OFFSET 0x0E)

The CalibrationInset register defines the expected position of the calibration points, inset from the perimeter of the touch sensor's active area, by a percentage of the full scale dimension.

This allows for the calibration targets to be placed inset from edge to make it easier for a user to touch them.

The CalibrationInset register value is only used when the CALIBRATION\_MODE command is issued to the controller. In Calibration mode, the controller will extrapolate the calibration point touch report values by the defined CalibrationInset percentage to achieve full scale.

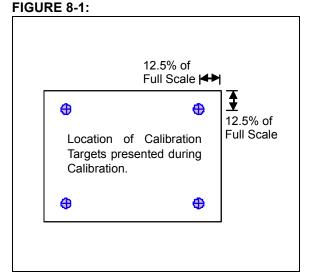
A software application that issues the CALIBRATION\_MODE command must present the displayed calibration targets at the same inset percentage as defined in this CalibrationInset register.

Valid values are as follows:

 $0 \leq \text{CalibrationInset} \leq 40$ 

Calibration Inset = (CalibrationInset/2) %, Range of 0-20% with 0.5% resolution

For example, CalibrationInset = 25 (0x19) yields a calibration inset of (25/2) or 12.5%. During the calibration procedure, the controller will internally extrapolate the calibration point touch values in Calibration mode by 12.5% to achieve full scale.



#### 8.2.13 PenStateReportDelay Register (OFFSET 0x0F)

The PenStateReportDelay register sets the delay time between sending of sequential touch reports for the "Pen-Down" and "Pen-Up" Touch mode states. See **Section 8.2.10 "TouchMode Register (offset 0x0C)"** for touch modes.

For example, if "Pen-Up" state of the TouchMode register is configured to send a touch report with P=1, followed by a touch report with P=0, then this delay occurs between the two touch reports. This provides some timing flexibility between the two touch reports that may be desired in certain applications. Valid values are as follows.

 $0 \leq \text{PenStateReportDelay} \leq 255$ 

Pen State Report Delay Time = PenStateReportDelay \* 50 µs

## 8.2.14 TouchReportDelay Register (OFFSET 0x11)

The TouchReportDelay register sets a forced delay time between successive touch report packets. This allows slowing down of the touch report rate, if desirable for a given application. For example, a given application may not need a high rate of touch reports and may want to reduce the overhead used to service all of the touch reports being sent. In this situation, increasing the value of this register will reduce the rate at which the controller sends touch reports. Valid values are as follows:

 $0 \leq \text{TouchReportDelay} \leq 255$ 

Touch Report Delay Time ≈ TouchReportDelay \* 500 µs

## 9.0 COMMANDS

### 9.1 Sending Commands

#### 9.1.1 COMMAND SEND FORMAT

The controller supports application-specific configuration commands as shown in Table 9-1, below.

#### TABLE 9-1: COMMAND SEND FORMAT

Byte #	Name	Value	Description
1	Header	0x55	Header (mark beginning of command packet)
2	Size	0x<>	Size, # of bytes following this byte
3	Command	0x<>	Command ID
4	Data	0x<>	Data, if applicable for the command
:	Data	0x<>	Data, if applicable for the command

To ensure command communication is not interrupted by touch activity, it is recommended that the controller touch is disabled, prior to other commands. This can be done as follows:

- 1. Send DISABLE\_TOUCH command
- 2. Wait 50 ms
- 3. Send desired commands
- 4. Send ENABLE\_TOUCH command

#### 9.1.2 COMMAND RESPONSE

A received command will be responded to as seen in Table 9-2 below.

#### TABLE 9-2: COMMAND RESPONSE FORMAT

Byte #	Name	Value	Description
1	Header	0x55	Header (mark beginning of command packet)
2	Size	0x<>	Size, # of bytes following this byte
3	Status	0x<>	Status
4	Command	0x<>	Command ID
5	Data	0x<>	Data, if applicable for the command
:	Data	0x<>	Data, if applicable for the command

The "Status" value within the response packet should be one of the following (See Table 9-3):

## TABLE 9-3:COMMAND RESPONSESTATUS VALUES

Status Value	Description
0x00	Success
0x01	Command Unrecognized
0x03	Header Unrecognized
0x04	Command Time Out (exceeded ~100 ms)
0xFC	Cancel Calibration mode

#### 9.1.3 DISABLE TOUCH BEFORE SENDING SUBSEQUENT COMMANDS

The AR1000 does not support full duplex communications. It cannot send touch reports to the host simultaneously with receiving commands from the host.

Disable AR1000 touch reporting prior to sending any other command(s), then re-enable touch reporting when complete with executing other commands.

1. Send the DISABLE\_TOUCH command.

Check for expected command response.

2. Send a desired command.

Check for expected command response.

- 3. Repeat at step 2 if another command is to be sent.
- 4. Send the ENABLE\_TOUCH command.

Check for expected command response.

#### 9.1.4 CONFIRM COMMAND IS SENT

Confirm each command sent to the AR1000, prior to issuing another command, to ensure it is executed. This is accomplished by evaluating the AR1000 response to a command that has been sent to it.

Check for each of the following five conditions to be met (See Table 9-4).

#### TABLE 9-4: COMMAND RESPONSE ERROR CONDITIONS

Condition	Response Byte	Description
Header	1	Header 0x55 value is expected
Size	2	Size 0x<> value to match what is expected for command sent
Status	3	Status 0x00 "success" value is expected
ID	4	Command ID 0x<> value to match what is expected (ID of sent command)
Data	5 to end	Data byte count to match what is expected for command sent

0x<> represents a value that is dependent on the command.

An error has occurred if no response is received at all or if any of the above conditions are not met in the response from the AR1000. If an error condition occurs, delay for a period of  $\sim$ 50 ms then send the same command again.

## 9.2 AR1000 Commands

## TABLE 9-5: COMMAND SET SUMMARY

Command Value	Command Description
0x10	GET_VERSION
0x12	ENABLE_TOUCH
0x13	DISABLE_TOUCH
0x14	CALIBRATE_MODE
0x20	REGISTER_READ
0x21	REGISTER_WRITE
0x22	REGISTER_START_ADDRESS_REQUEST
0x23	REGISTERS_WRITE_TO_EEPROM
0x28	EEPROM_READ
0x29	EEPROM_WRITE
0x2B	EEPROM_WRITE_TO_REGISTERS

## 9.3 AR1000 Command Descriptions

9.3.1 GET VERSION - 0x10

Controller will return version number and type.

Send: <0x55><0x01><0x10>

Receive: <0x55><0x05><Response><0x10><Version High><Version Low><Type>

where <Type>

## **REGISTER 9-1:** GET VERSION **<TYPE> FORMAT**

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
RS1	RS0	TP5	TP4	TP3	TP2	TP1	TP0
bit 7							bit 0

Legend:		
R = Reada	ble bit W = Writable bit	U = Unimplemented bit, read as '0'
bit 7-6	RS<1:0>: Resolution of Touch Coordinate 00 = 8-bit 01 = 10-bit	s bits
bit 5-0	10 = 12-bit <b>TP&lt;5:0&gt;:</b> Type of Controller bits 001010 = ARA10	0.0.0
Controller v touch condi	ENABLE_TOUCH – 0x12 vill send touch coordinate reports for valid tions. 0x55><0x01><0x12>	9.3.3 DISABLE_TOUCH – 0x13 Controller will not send any touch coordinate reports. A touch will, however, still wake-up the controller if asleep.
Receive: <	0x55><0x02> <response>&lt;0x12&gt;</response>	Send: <0x55><0x01><0x13> Receive: <0x55><0x02> <response>&lt;0x13&gt;</response>

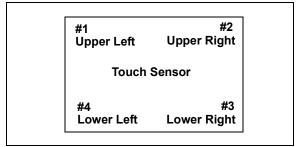
## 9.3.4 CALIBRATE - 0x14

Enter Calibration mode. This instructs the controller to enter a mode of accepting the next four touches as the calibration point coordinates. See Section 10.1 "Calibration of Touch Sensor with Controller" for an example.

Completion of Calibration mode will automatically store the calibration point coordinates in on-board controller memory and set (to 1) the CCE bit of the TouchOptions register. This bit enables the controller to report touch coordinates that have been processed with the previously collected calibration data.

To provide for proper touch orientation, the four sequential calibration touches must be input in the physical order on the touch sensor, as shown in Figure 9-1.

# FIGURE 9-1: CALIBRATION ROUTINE SEQUENCE



Upon completion, the controller's register values and calibration data are stored to the EEPROM.

The Calibration mode will be cancelled by sending any command before the mode has been completed. If the calibration is canceled, the controller response may appear incorrect or incomplete. This is expected behavior.

## 9.3.4.1 AR1010/AR1020 Calibrate Response

Send: <0x55><0x02><0x14><Calibration Type>

Calibration Type

0x04

Receive: <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14>

A successful CALIBRATE command results in 5 response packets being sent to the host.

Once the response has been received for the completed 4<sup>th</sup> target, a delay of one second must be implemented prior to sending any commands to the controller. This one second delay insures all data has been completely written to the EEPROM.

## 9.3.4.2 AR1011/AR1021 Calibrate Response

Send: <0x55><0x02><0x14><Calibration Type>

# Calibration Type

Receive: <0x55><0x02><0x00><0x14>

<0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14> <0x55><0x02><0x00><0x14>

A successful <code>CALIBRATE</code> command results in six response packets being sent to the host.

**Description** 

4 point

for initial command response

Response for touch of Calibration point #1

Response for touch of Calibration point #2 Response for touch of Calibration point #3 Response for touch of Calibration point #4

## Description

4 point

for initial command response

Response for touch of Calibration point #1 Response for touch of Calibration point #2 Response for touch of Calibration point #3 Response for touch of Calibration point #4 Response after EEPROM has been written

# 9.3.4.3 Calibration Data Encoded and Stored in EEPROM

System integrators may prefer to pre-load a calibration into their design. This allows the user to properly navigate to the calibration routine icon or shortcut without the use of a mouse. This also addresses the need to calibrate each system individually before deploying it to the field. The raw touch coordinates, decoded by the controller, for each of the four calibration touches are extrapolated if CalibrationInset was non-zero. The four coordinate pairs are then re-oriented, if required, such that the upper left corner is the minimum (X,Y) "origin" value pair and the lower right corner is the maximum (X,Y) value pair.

Coordinates are 10-bit significant values, scaled to 16-bit and stored in a High (Hi) and Low (Lo) byte pair.

Separator	Upp	er Le	eft (No	de 1)	Upper Right (No			le 2)	Lowe	er Rig	ht (No	de 3)	Lo	wer Le	eft (Noc	le 4)	Flip State
	>	<	١	(	Х	(	Y	/	>	(	``	Y		Х	`	Y	
	Lo	Hi	Lo	Hi	Lo	Hi	Lo	Hi	Lo	Hi	Lo	Hi	Lo	Hi	Lo	Hi	

Decode the above data to as follows:

- 1. Swap the order of stored low and high bytes for a given coordinate.
- 2. Convert the 16-bit value (stored high and low bytes) from hexadecimal to decimal.
- 3. Divide the result by 64 to properly rescale the 16-bit stored value back to a 10-bit significant coordinate.

Example of Low = 0x40 and High = 0xF3:

Swap: 0xF340

Hex to Decimal: 62272

Divide by 64: 973

## **REGISTER 9-2:** Flip State Byte

U-0	U-0	U-0	U-0	U-0	R/W	R/W	R/W
—	—	—	_	—	XYFLIP	XFLIP	YFLIP
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	

bit 7-3	Unimplemented: Read as '0'
bit 2	<b>XYFLIP:</b> X and Y Axis Flip bit 1 = X and Y axis are flipped 0 = X an Y axis are not flipped
bit 1	<b>XFLIP:</b> X-Axis Flip bit 1 = X-axis flipped 0 = X-axis not flipped
bit 0	<b>YFLIP:</b> Y-Axis Flip bit 1 = Y-axis flipped 0 = Y-axis not flipped

For storing desired calibration values to the EEPROM:

 AR1010/AR1020 (See Section 9.3.12 "EEPROM Map").

 AR1011/AR1021 (See Section 9.3.12 "EEPROM Map" and Section 10.2 "AR1011/AR1021 Storing Default Calibration Values to EEPROM").

#### 9.3.5 REGISTER READ - 0x20

Reads a value from a controller register location. This can be used to determine a controller configuration settina.

Configuration registers are defined as an Offset value from the Start address for the register group. Read a register as follows:

- 1. Issue the register start address request command to obtain the Start address for the register group.
- 2. Calculate the desired register's absolute address by adding the register's Offset value to Start address for the register group.
- 3. Issue this REGISTER READ command, as follows, using the calculated register's absolute address:
- Send: <0x55><0x04><0x20><Register Address High byte><Register Address Low byte><# of Registers to Read>

Register Address High byte: 0x00

# of Registers to Read: 0x01 thru 0x08

Receive: <0x55><0x02 + # of Registers Read><Response><0x20><Register value>...<Register value>

The AR1000 controller will ignore the value entered for the Register Address High Byte. However, 0x00 is recommended to safeguard against any possible future product development.

#### 9.3.6 REGISTER WRITE -0x21

Write a value to a controller register location. This can be used to change a controller configuration setting.

Configuration registers are defined as an Offset value from the Start address for the register group. Write a register as follows:

- Issue the REGISTER START ADDRESS REQUEST 1. command to obtain the Start address for the register group.
- 2. Calculate the desired register's absolute address by adding the register's Offset value to Start address for the register group.
- Issue this REGISTER WRITE command, as 3. follows, using the calculated register's absolute address:
- **Send:** <0x55><0x04 + # Registers t o Write><0x21><Register Address High byte><Register Address Low byte>

of Registers Write><Data>...<Data>

Register Address High byte: 0x00

# of Registers to Read: 0x01 thru 0x08

Receive: <0x55><0x02><Response><0x21>

The AR1000 controller will ignore the value entered for the Register Address High Byte. However, 0x00 is recommended to safeguard against any possible future product development.

9.3.7 REGISTER START ADDRESS REQUEST -0x22

Configuration registers are defined as an Offset value from the Start address for the register group. This command returns the Start address for the register group.

Send: <0x55><0x01><0x22>

Receive:

<0x55><0x03><Response><0x22><Regi ster Start Address>

9.3.8 REGISTERS WRITE TO EEPROM -0x23

Save Configuration register values to EEPROM. This allows the controller to remember configurations settings through controller power cycles.

Send: <0x55><0x01><0x23>

Receive: <0x55><0x02><Response><0x23>

9.3.9 EEPROM READ-0X28

The controller has 256 bytes of on-board EEPROM.

- The first 128 bytes (address range 0x00-0x7F) are reserved by the controller for the Configuration register settings and calibration data.
- · The second 128 bytes (address range 0x80-0xFF) are provided for the user's application, if desired.

This command provides a means to read values from the EEPROM.

Send: <0x55><0x04><0x28><EEPROM Address High byte><EEPROM Address Low byte><# of EEPROM to Read>

Register Address High byte: 0x00

# of Registers to Read: 0x01 thru 0x08

Receive: <0x55><0x02 + # EEPROM Read><Response><0x28><EEPROM value>...<EEPROM value>

The AR1000 controller will ignore the value entered for the EEPROM Address High Byte. However, 0x00 is recommended to safeguard against any possible future product development.

<#

t.o

## 9.3.10 EEPROM WRITE - 0x29

The controller has 256 bytes of on-board EEPROM.

This command provides a means to write values to the user space within the EEPROM.

- The first 128 bytes (address range 0x00-0x7F) are reserved by the controller for the Configuration register settings and calibration data. Only the Register Write to EEPROM command should be used to write Configuration registers to EEPROM. Failure to use the Register Write command to save Configuration registers to EEPROM may result in failures or reverting to previously stored Configuration register values.
- The second 128 bytes (address range 0x80-0xFF) are provided for the user's application, if desired.

-	DNLY write to user EEPROM addresses of 0x80-0xFF.
E	Dne of the following actions is required for EEPROM changes to be used by the controller:
	The controller power must be cycled from OFF to ON or
	Issue the
	EEPROM_WRITE_TO_REGISTERS
	command.
Write to EEC	POM as follows:

Write to EEPROM as follows:

Send:	<0x55><0x	:04	+	#	EEPROM	to
	Write><0x	29> <e< th=""><th>EPRO</th><th>М</th><th>Address</th><th>High</th></e<>	EPRO	М	Address	High
	byte> <eef< th=""><th>ROM A</th><th>ddre</th><th>SS</th><th>Low byte</th><th>&gt;</th></eef<>	ROM A	ddre	SS	Low byte	>
	<#	of		ΕE	PROM	to
	Write> <da< th=""><th>ata&gt;&lt;</th><th>Data</th><th>&gt;</th><th></th><th></th></da<>	ata><	Data	>		
	Register Ad	dress H	ligh b	yte	: 0x00	

# of Registers to Read: 0x01 thru 0x08

Receive: <0x55><0x02><Response><0x29>

The AR1000 controller will ignore the value entered for the EEPROM Address High Byte. However, 0x00 is recommended to safeguard against any possible future product development.

# 9.3.11 EEPROM\_WRITE\_TO\_REGISTERS - 0x2B

Write applicable EEPROM data to Configuration registers. This will cause the controller to immediately begin using changes made to EEPROM stored Configuration register values. A power cycle of the controller will automatically cause the controller to use changes made to the EEPROM stored Configuration register values, without the need for issuing this command. This command eliminates the need for the power cycle.

Send: <0x55><0x01><0x2B>

Receive: <0x55><0x02><Response><0x2B>

## 9.3.12 EEPROM MAP

The first 128 bytes in address range 0x00:0x7F are reserved by the controller for the Configuration register settings and calibration data. The mapping of data in this reserved controller space of the EEPROM may change over different revisions within the product lifetime.

The EEPROM\_WRITE command must not be used to write directly to the lower 128 bytes of the controller EEPROM space of 0x00:0x7F.

The second 128 bytes in address range 0x80:0xFF are provided for the user's application, if desired.

EEPROM Address	Function
0x00	<special use=""></special>
0x01	<special use=""></special>
0x02	<special use=""></special>
0x03	Touch Threshold
0x04	Sensitivity Filter
0x05	Sampling Fast
0x06	Sampling Slow
0x07	Accuracy Filter Fast
0x08	Accuracy Filter Slow
0x09	Speed Threshold
0x0A	<special use=""></special>
0x0B	Sleep Delay
0x0C	Pen-Up Delay
0x0D	Touch Mode
0x0E	Touch Options
0x0F	Calibration Inset
0x10	Pen State Report Delay
0x11	<reserved></reserved>
0x12	Touch Report Delay
0x13	<special use=""></special>
0x14	Data Block Separator
0x15	Calibration UL X-low
0x16	Calibration UL X-high
0x17	Calibration UL Y-low
0x18	Calibration UL Y-high
0x19	Calibration UR X-low
0x1A	Calibration UR X-high
0x1B	Calibration UR Y-low
0x1C	Calibration UR Y-high
0x1D	Calibration LR X-low
0x1E	Calibration LR X-high
0x1F	Calibration LR Y-low

## TABLE 9-6: AR1010/AR1020 EEPROM AND REGISTER MAP

# TABLE 9-6:AR1010/AR1020 EEPROM<br/>AND REGISTER MAP

EEPROM Address	Function
0x20	Calibration LR Y-high
0x21	Calibration LL X-low
0x22	Calibration LL X-high
0x23	Calibration LL Y-low
0x24	Calibration LL Y-high
0x25	Calibration Flip State
0x26:0x7E	<special use=""></special>
0x7F	End of Controller Space
0x80:0xFF	User Space

# TABLE 9-7:AR1011/AR1021 EEPROMAND REGISTER MAP

EEPROM Address	Function
0x00	Not used
0x01	Configuration Registers – Block Key
0x02	<special use=""></special>
0x03	<special use=""></special>
0x04	Touch Threshold
0x05	Sensitivity Filter
0x06	Sampling Fast
0x07	Sampling Slow
0x08	Accuracy Filter Fast
0x09	Accuracy Filter Slow
0x0A	Speed Threshold
0x0B	<special use=""></special>
0x0C	Sleep Delay
0x0D	Pen-Up Delay
0x0E	Touch Mode
0x0F	Touch Options
0x10	Calibration Inset
0x11	Pen State Report Delay
0x12	<special use=""></special>
0x13	Touch Report Delay
0x14	<special use=""></special>
0x15	Configuration Registers – Checksum
0x16	Calibration - Block Key
0x17	Calibration UL X-low
0x18	Calibration UL X-high
0x19	Calibration UL Y-low
0x1A	Calibration UL Y-high
0x1B	Calibration UR X-low
0x1C	Calibration UR X-high

# TABLE 9-7:AR1011/AR1021 EEPROM<br/>AND REGISTER MAP

Function
Calibration UR Y-low
Calibration UR Y-high
Calibration LR X-low
Calibration LR X-high
Calibration LR Y-low
Calibration LR Y-high
Calibration LL X-low
Calibration LL X-high
Calibration LL Y-low
Calibration LL Y-high
Calibration Flip State
Calibration – Checksum
<special use=""></special>
<reserved></reserved>
User Space

NOTES:

#### 10.0 **APPLICATION NOTES**

#### 10.1 Calibration of Touch Sensor with Controller

The reported coordinates from a touch screen controller are typically calibrated to the application's video display. The task is often left up to the host to perform. This controller provides a feature for it to send coordinates that have already been calibrated, rather than the host needing to perform this task. If enabled, the feature will apply pre-collected 4-point calibration data to the reported touch coordinates. Calibration only accounts for X and Y directional scaling. It does not correct for angular errors due to rotation of the touch sensor on the video display.

The calibration process can be cancelled at anytime by sending a command to the controller.

Upon completion of the calibration process, the calibration data is automatically stored to the EEPROM and "Calibrated Coordinates" is enabled.

The process of "calibration" with the controller is described below.

Disable touch reporting by issuing <Disable 1. Touch> command.

Send: <0x55><0x01><0x13>

Receive: <0x55><0x02><Response><0x13>

2. Get register group Start address by issuing REGISTER START ADDRESS REQUEST command.

## A register Start address of 0x20 is used below, for this example.

Send: <0x55><0x01><0x22>

**Receive:** <0x55><0x03><0x00><0x22><0x20>

Calculate the CalibrationInset register's address by adding its offset value of 0x0E to the register group Start address of 0x20.

Register Address = Register Start Address + CalibratioInset Register Offset = 0x20 + 0x0E = 0x2E

4 Calculate the desired value for the CalibrationInset register.

A Calibration Inset of 12.5% is used below for this example.

CalibrationInset = 2 \* Desire Calibration Inset % = 2 \* 12.5 = 25 = 0x19

5. Set the Calibration Inset by writing the desired value to the CalibrationInset register.

Send:<0x55><0x05><0x21><0x00><0x2E><0x01 ><0x19>

Receive: <0x55><0x02><0x00><0x21>

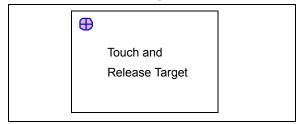
6. Issue the CALIBRATE MODE command.

Send: <0x55><0x02><0x14><0x04>

Receive: <0x55><0x02><0x00><0x14>

7. Software must display the first calibration point target in the upper left quadrant of the display and prompt the user to touch and release the target.

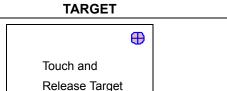
#### **FIGURE 10-1:** SUGGESTED TEXT FOR **FIRST CALIBRATION** TARGET



8. Wait for the user to touch and release the first calibration point target. Do this by looking for a controller response of: <0x55><0x02><0x00> <0x14>

9. Software must display the second calibration point target in the upper right quadrant of the display and prompt the user to touch and release the target.

#### **FIGURE 10-2:** SUGGESTED TEXT FOR SECOND CALIBRATION



10. Wait for the user to touch and release the second calibration point target. Do this by looking for a controller response of: <0x55><0x02><0x00><0x14>

11. Software must display the third calibration point target in the lower right quadrant of the display and prompt the user to touch and release the target.

FIGURE 10-3: SUGGESTED TEXT FOR THIRD CALIBRATION TARGET



- Wait for the user to touch and release the third calibration point target. Do this by looking for a controller response of:
   <0x55><0x02><0x00><0x14>
- 13. Software must display the fourth calibration point target in the lower left quadrant of the display and prompt the user to touch and release the target.

## FIGURE 10-4: SUGGESTED TEXT FOR FOURTH CALIBRATION TARGET



- 14. Wait for the user to touch and release the fourth calibration point target. Do this by looking for a controller response of:
   <0x55><0x02><0x00><0x14>
- 15. Wait for the controller to correctly write calibration data into EEPROM
  - AR1010/AR1020: Wait one second for data to be stored into EEPROM
  - AR1011/AR1021: Wait for a controller response of <0x55><0x02><0x00><0x14>
- 16. Enable touch reporting by issuing ENABLE TOUCH command.

Send: <0x55><0x01><0x12>

Receive: <0x55><0x02><Response><0x12>

## 10.2 AR1011/AR1021 Storing Default Calibration Values to EEPROM

If you wish to implement fixed calibration values, pre-loaded into the AR1000 EEPROM, then the following procedure must be followed (See Section 10.2.1 "Preparation for Fixed Calibration Values").

## 10.2.1 PREPARATION FOR FIXED CALIBRATION VALUES

Determine if fixed calibration values are suitable for your application and determine your desired values.

Calculate a checksum for your custom data set. See Section 9.3.4.3 "Calibration Data Encoded and Stored in EEPROM" for additional details regarding calibration data format. An example of calculating the checksum is shown below (See Table 10-1).

Dese	cription		Value	Operation	Checksum Result
Seed			0x45	n/a	0x45
Block Key			0x55	0x45 + 0x55 =	0x9A
Upper Left	Х	Low byte	0x06	0x9A + 0x06 =	0xA0
Upper Left	Х	High byte	0x1B	0xA0 + 0x1B =	0xBB
Upper Left	Y	Low byte	0xA5	0xBB + 0xA5 =	0x60
Upper Left	Y	High byte	0x08	0x60 + 0x08 =	0x68
Upper Right	Х	Low byte	0x13	0x68 + 0x13 =	0x7B
Upper Right	Х	High byte	0xDF	0x7B + 0xDF =	0x5A
Upper Right	Y	Low byte	0xF4	0x5A + 0xF4 =	0x4E
Upper Right	Y	High byte	0x0B	0x4E + 0x0B =	0x59
Lower Right	Х	Low byte	0x98	0x59 + 0x98 =	0xF1
Lower Right	Х	High byte	0xE4	0xF1 + 0xE4 =	0xD5
Lower Right	Y	Low byte	0x1E	0xD5 + 0x1E =	0xF3
Lower Right	Y	High byte	0xEC	0xF3 + 0xEC =	0xDF
Lower Left	Х	Low byte	0xBF	0xDF + 0xBF =	0x9E
Lower Left	Х	High byte	0x1A	0x9E + 0x1A =	0xB8
Lower Left	Y	Low byte	0x32	0xB8 + 0x32 =	0xEA
Lower Left	Y	High byte	0xE7	0xEA + 0xE7 =	0xD1
Flip State			0x01	0xD1 + 0x01 =	0xD2
Checksum					0xD2

## TABLE 10-1: CHECKSUM CALCULATION EXAMPLE

The Checksum is an 8-bit value calculated by successive additions with overflow ignored, as shown below.

Checksum = 0x45

For each of the 18 calibration values, starting at the Block Key and ending with the Flip State

Checksum += Calibration value

Next Calibration value

© 2009-2012 Microchip Technology Inc.

## 10.2.2 EXECUTION OF FIXED CALIBRATION VALUE LOADING

Follow error checking practices by checking the AR1000 responses to issued commands.

- 1. Send the AR1000 DISABLE TOUCH command.
- 2. Use the AR1000 EEPROM\_WRITE command multiple times to write the following to the AR1000 EEPROM.
  - a. Block Key 0x55 to address 0x16
  - b. Data set to addresses 0x17:0x27. See Section 9.3.4.3 "Calibration Data Encoded and Stored in EEPROM" and Section 9.3.12 "EEPROM Map".
  - c. Checksum for the data block to address 0x28
  - d. Mirror image of a, b and c from above to address 0x3E:0x50
- Set the CCE bit of the TouchOptions register. This will enable the controller to use the calibration data on the next power boot. See Section 10.2.3 "Configuring the CCE bit to Use Fixed Calibration Values" for additional details on the CCE bit.
- 4. Send the AR1000  ${\tt ENABLE\_TOUCH}$  (0x12) command.
- 10.2.3 CONFIGURING THE CCE BIT TO USE FIXED CALIBRATION VALUES

The CCE bit of the TouchOptions Register (offset 0x0D) must be set to '1' to enable the usage of the stored calibration values in EEPROM.

This should be completed before re-enabling the controller via the ENABLE\_TOUCH command.

## REGISTER 10-1: CCE BIT FORMAT

U-0	U-0	U-0	U-0	U-0	U-0	R/W	R/W
—	—	—	—	—	—	48W	CCE
bit 7							bit 0

Legend:								
R = Readable bit		W = Writable bit	U = Unimplemented bit, read as '0'	as 'O'				
bit 7-2	Unimple	emented: Read as '0'						
bit 1	<b>48W:</b> 4-Wire or 8-Wire Sensor Selection bit 1 = Selects 8-wire Sensor Operating mode 0 = Selects 4-wire Sensor Operating mode							
bit 0	<b>CCE:</b> Calibrated Coordinates Enable bit 1 = Enables calibrated coordinates, if the controller has been calibrated 0 = Disables calibrated coordinates							

- 1. Send the DISABLE TOUCH (0x13) command.
- 2. Send the REGISTER\_START\_ADDRESS\_REQUEST (0x22) to determine the absolute address for TouchOptions Register.
- 3. Send the REGISTER\_WRITE (0x21) command to set the CCE bit of the TouchOptions Register.
- 4. Send REGISTERS\_WRITE\_TO\_EEPROM (0x23) command to have all current registers stored into EEPROM.
- 5. Send the AR1000 ENABLE\_TOUCH (0x12) command.

The controller will use the stored calibration data after cycling power to the controller.

## 10.2.4 EEPROM\_WRITE COMMAND TO STORE DEFAULT CALIBRATION

The EEPROM\_WRITE command is shown in this section. See Section 9.0 "Commands" for more command details.

<> = application specific value

#### Send to AR1000:

Header
Number of bytes to follow this one
Command ID
Desired EEPROM address to write high byte. Always 0x00
Desired EEPROM address to write low byte
Number of consecutive EEPROM addresses to write (supports 0x01 to 0x08)
Value # 1 to write
Value # 2 to write, if applicable
Value # 3 to write, if applicable
Value # 4 to write, if applicable
Value # 5 to write, if applicable
Value # 6 to write, if applicable
Value # 7 to write, if applicable
Value # 8 to write, if applicable

#### Response from AR1000:

0x55	Header
0x02	Number of bytes to follow this one
0x00	Success response
0x29	Command ID

## 10.2.5 QUALITY TEST

Although not required, a level of quality assurance can be added to the process by the application issuing multiple EEPROM\_READ commands to the AR1000.

The response data from the EEPROM\_READ commands would be tested by the application against the application's desired data as a quality check.

## 10.2.6 EXAMPLE COMMAND SEQUENCE

An example eight command sequence for the entire process is shown below.

All values shown are in hexadecimal.

Calibration values are applications specific and have been symbolically represented as follows:

## ULxL = Upper Left corner x-coordinate Low byte

## LLyH = Lower Left corner y-coordinate High byte

DISABLE\_TOUCH

Disable Touch														
Command:	55	01	13											
Response:	55	02	00	13										
Write Calibration t					-									
Command:	55	0C	29	00	16	08	55	ULxL	ULxH	ULyL	ULyH	URxL	URxH	URyL
Response:	55	02	00	29										
Command:	55	0C	29	00	1E	08	URyH	LRxL	LRxH	LRyL	LRyH	LLxL	LLxH	LLyL
Response:	55	02	00	29										
Command:	55	07	29	00	26	03	LLyH	FlipS	Chksm					
Response:	55	02	00	29										
Write Calibration t	o EEF	PROM	Imag	<u>ge # 2</u>	<u>!</u>									
Command:	55	0C	29	00	3E	08	55	ULxL	ULxH	ULyL	ULyH	URxL	URxH	URyL
Response:	55	02	00	29										
Command:	55	0C	29	00	46	08	URyH	LRxL	LRxH	LRyL	LRyH	LLxL	LLxH	LLyL
Response:	55	02	00	29										
Command:	55	07	29	00	4E	03	LLyH	FlipS	Chksm					
Response:	55	02	00	29										
			_											
Enable Use of Ca			_											
Command:	55 55	01	22	00										
Response:	55	03	00	22	<stai< td=""><td>rt Ad</td><td>dress&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></stai<>	rt Ad	dress>							
Command:		<u> </u>												
4/8-Wire	55	05	21	00			ldress +		01	01				
5-Wire	55	05	21	00	<stai< td=""><td>rt Ad</td><td>dress +</td><td>0x0D&gt;</td><td>01</td><td>03</td><td></td><td></td><td></td><td></td></stai<>	rt Ad	dress +	0x0D>	01	03				
Response:	55	02	00	21										
Enable Touch														
Command:	55	01	12											
Response:	55	02	00	12										

## 11.0 ELECTRICAL SPECIFICATIONS

## Absolute Maximum Ratings<sup>(†)</sup>

Ambient temperature under bias	40°C to +125°C
Storage temperature	65°C to +150°C
Voltage on VDD with respect to Vss	-0.3V to +6.5V
Voltage on all other pins with respect to Vss	0.3V to (VDD + 0.3V)
Total power dissipation	
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current (VI < 0 or VI > VDD)	± 20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

† NOTICE: This device is sensitive to ESD damage and must be handled appropriately. Failure to properly handle and protect the device in an application may cause partial to complete failure of the device.

## 11.1 Minimum Operating Voltage

The AR1000 series controller will operate down to  $2.5V \pm 5\%$ . Touch performance will be optimized by using the highest allowable voltage for the design.

The PICkit Serial included in the AR1000 Development kit supports 3V-5V range of operation.

## 11.2 AR1000 Electrical Characteristics

Operating Voltage: 2.5 ≤ VDD ≤ 5.25V							
Function	Pin	Input	Output				
M1	M1	Vss ≤ <b>Vil</b> ≤ 0.15*Vdd (0.25*Vdd + 0.9V) ≤ <b>Vih</b> ≤ Vdd	—				
M2	M2	Vss ≤ <b>Vil</b> ≤ 0.15*Vdd (0.25*Vdd + 0.9V) ≤ <b>Vih</b> ≤ Vdd	_				
SCL/SCK	SCL/SCK/TX	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>Viн</b> ≤ Vdd	-				
ТХ	SCL/SCK/TX	-	Vss ≤ $VoL^{(1)}$ ≤ $(1.2V - 0.15*VDD)^{(2)}$ $(1.25*VDD - 2.25V)^{(3)}$ ≤ $VoH^{(1)}$ ≤ $VDD$				
SDI	SDI/SDA/RX	Vss ≤ <b>ViL</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>VIH</b> ≤ Vdd	_				
SDO	SDO	_	$V_{SS} \le V_{OL}^{(1)} \le (1.2V - 0.15^*V_{DD})^{(2)}$ $(1.25^*V_{DD} - 2.25V)^{(3)} \le V_{OH}^{(1)} \le V_{DD}$				
SIQ	SIQ	—	$V_{SS} \le V_{OL}^{(1)} \le (1.2V - 0.15^*V_{DD})^{(2)}$ $(1.25^*V_{DD} - 2.25V)^{(3)} \le V_{OH}^{(1)} \le V_{DD}$				
SDA	SDI/SDA/RX	Vss ≤ <b>ViL</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>VIH</b> ≤ Vdd	Open-drain				
RX	SDI/SDA/RX	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>VIH</b> ≤ Vdd	—				
SS	SS	Vss ≤ <b>Vil</b> ≤ 0.2*Vdd 0.8*Vdd ≤ <b>Vih</b> ≤ Vdd	—				

**Note 1:** These parameters are characterized but not tested.

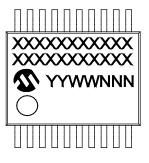
2: At 10 mA.

**3:** At -4 mA.

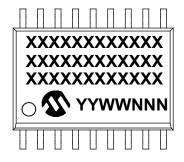
## 12.0 PACKAGING INFORMATION

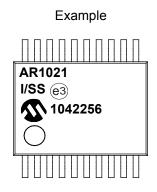
## 12.1 Package Marking Information

20-Lead SSOP (5.30 mm)



20-Lead SOIC (7.50 mm)





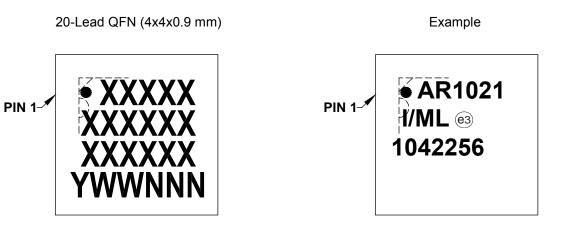
Example



Legend	: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

\* Standard PICmicro<sup>®</sup> device marking consists of Microchip part number, year code, week code and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

## 12.2 Package Marking Information (Continued)



Legend	: XXX Y YY WW NNN (e3) *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
	be carried	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

\* Standard PICmicro<sup>®</sup> device marking consists of Microchip part number, year code, week code and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

## 12.3 Ordering

Note:	The AR1011/AR1021 are recommended
	for new designs. The AR1010/AR1020 are
	still supported and available, but are not
	recommended for new designs.

Part Number	Communication Type	Temp. Range	Pin Package	Packing
AR1011-I/ML	UART	-40°C to + 85°C	QFN, 20 pin	Tube
AR1011-I/SO	UART	-40°C to + 85°C	SOIC, 20 pin	Tube
AR1011-I/SS	UART	-40°C to + 85°C	SSOP, 20 pin	Tube
AR1011T-I/ML	UART	-40°C to + 85°C	QFN, 20 pin	T/R
AR1011T-I/SO	UART	-40°C to + 85°C	SOIC, 20 pin	T/R
AR1011T-I/SS	UART	-40°C to + 85°C	SSOP, 20 pin	T/R
AR1021-I/ML	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	QFN, 20 pin	Tube
AR1021-I/SO	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SOIC, 20 pin	Tube
AR1021-I/SS	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SSOP, 20 pin	Tube
AR1021T-I/ML	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	QFN, 20 pin	T/R
AR1021T-I/SO	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SOIC, 20 pin	T/R
AR1021T-I/SS	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SSOP, 20 pin	T/R
AR1010-I/ML	UART	-40°C to + 85°C	QFN, 20 pin	Tube
AR1010-I/SO	UART	-40°C to + 85°C	SOIC, 20 pin	Tube
AR1010-I/SS	UART	-40°C to + 85°C	SSOP, 20 pin	Tube
AR1010T-I/ML	UART	-40°C to + 85°C	QFN, 20 pin	T/R
AR1010T-I/SO	UART	-40°C to + 85°C	SOIC, 20 pin	T/R
AR1010T-I/SS	UART	-40°C to + 85°C	SSOP, 20 pin	T/R
AR1020-I/ML	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	QFN, 20 pin	Tube
AR1020-I/SO	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SOIC, 20 pin	Tube
AR1020-I/SS	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SSOP, 20 pin	Tube
AR1020T-I/ML	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	QFN, 20 pin	T/R
AR1020T-I/SO	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SOIC, 20 pin	T/R
AR1020T-I/SS	I <sup>2</sup> C <sup>TM</sup> /SPI	-40°C to + 85°C	SSOP, 20 pin	T/R

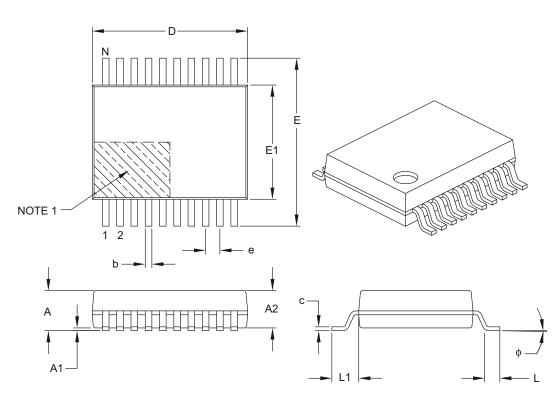
## TABLE 12-1: ORDERING PART NUMBERS

## 12.4 Package Details

The following sections give the technical details of the packages.

## 20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	6
Dimension	Dimension Limits		NOM	MAX
Number of Pins	Ν		20	
Pitch	е		0.65 BSC	
Overall Height	А	Ι	-	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	-	-
Overall Width	Е	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	6.90	7.20	7.50
Foot Length	L	0.55	0.75	0.95
Footprint L1			1.25 REF	
Lead Thickness	С	0.09	_	0.25
Foot Angle	¢	0°	4°	8°
Lead Width	b	0.22	_	0.38

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

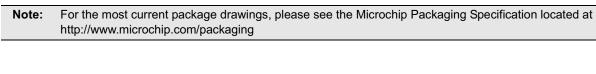
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.

3. Dimensioning and tolerancing per ASME Y14.5M.

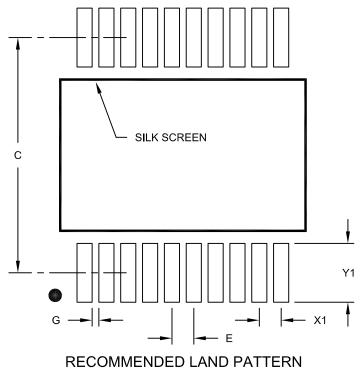
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B



20-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]



Units		Ν	<b>ILLIMETER</b>	S
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	С		7.20	
Contact Pad Width (X20)	X1			0.45
Contact Pad Length (X20)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

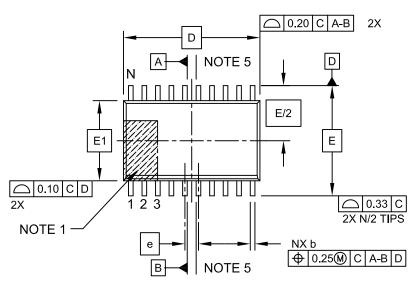
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

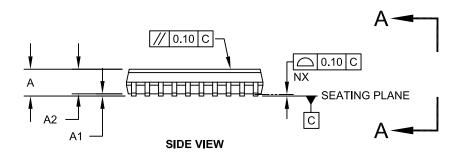
Microchip Technology Drawing No. C04-2072A

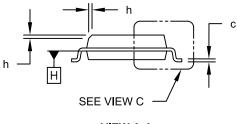
## 20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







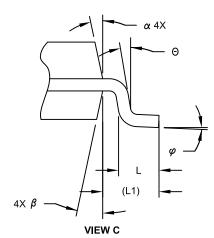


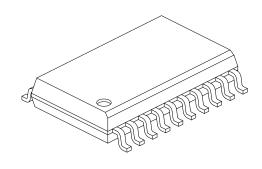
VIEW A-A

Microchip Technology Drawing C04-094C Sheet 1 of 2

## 20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





LIMETER	c		
MILLIMETERS			
NOM	MAX		
20			
27 BSC			
-	2.65		
-	-		
-	0.30		
10.30 BSC			
7.50 BSC			
12.80 BSC			
-	0.75		
-	1.27		
1.40 REF			
-	-		
-	8°		
-	0.33		
-	0.51		
-	15°		
-	15°		
	20 27 BSC - - 30 BSC 50 BSC 80 BSC - -		

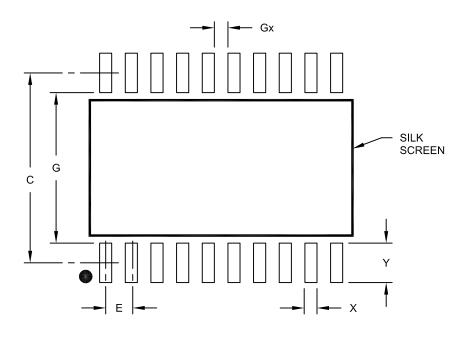
#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-094C Sheet 2 of 2

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



## RECOMMENDED LAND PATTERN

	Units		<b>ILLIMETER</b>	S
Dimension	Dimension Limits		NOM	MAX
Contact Pitch	E		1.27 BSC	
Contact Pad Spacing	С		9.40	
Contact Pad Width (X20)	X			0.60
Contact Pad Length (X20)	Y			1.95
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.45		

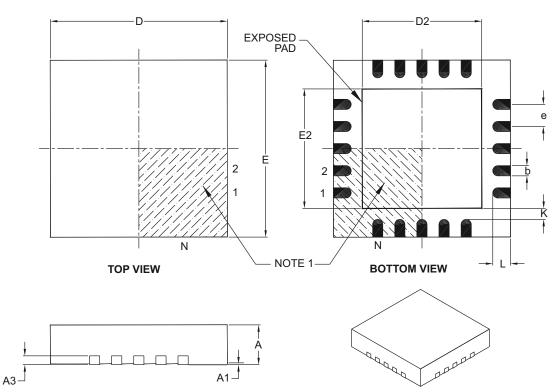
Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2094A

For the most current package drawings, please see the Microchip Packaging Specification located at



## 20-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

http://www.microchip.com/packaging

MILLIMETERS Units **Dimension Limits** MIN NOM MAX 20 Number of Pins Ν 0.50 BSC Pitch е Overall Height А 0.80 0.90 1.00 Standoff A1 0.00 0.02 0.05 **Contact Thickness** A3 0.20 REF Overall Width 4.00 BSC Е Exposed Pad Width E2 2.60 2.70 2.80 **Overall Length** 4.00 BSC D Exposed Pad Length D2 2.60 2.70 2.80 Contact Width 0.18 0.25 0.30 b 0.30 0.40 Contact Length L 0.50 Contact-to-Exposed Pad Κ 0.20 \_ \_

#### Notes:

Note:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

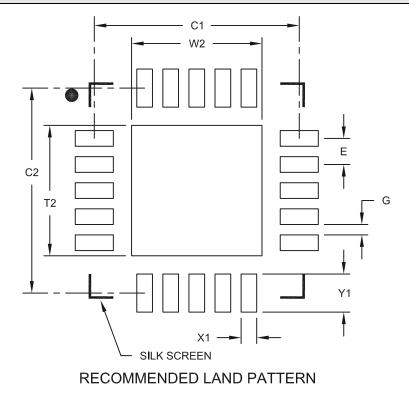
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-126B

<sup>© 2009-2012</sup> Microchip Technology Inc.

# 20-Lead Plastic Quad Flat, No Lead Package (ML) - 4x4 mm Body [QFN] With 0.40 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		Ν	MILLIMETER	S
Dimension Limits		MIN	NOM	MAX
Contact Pitch	Contact Pitch E		0.50 BSC	
Optional Center Pad Width	W2			2.50
Optional Center Pad Length	T2			2.50
Contact Pad Spacing	C1		3.93	
Contact Pad Spacing	C2		3.93	
Contact Pad Width	X1			0.30
Contact Pad Length	Y1			0.73
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2126A

## APPENDIX A: DATA SHEET REVISION HISTORY

## **Revision A (07/2009)**

Original release of this data sheet.

## **Revision B (03/2012)**

Updated data sheet.

## APPENDIX B:

Modifying, removing or adding components may adversely affect touch performance.

Specific manufacturers and part numbers are provided only as a guide. Equivalents can be used.

Label	Quantity	Value	Description	Manufacturer	Part Number
C1	1	10 uF	Capacitor – Ceramic, 10 uF, 20%, 6.3V, X7R, 0603	AVX	06036D106MAT2A
C2	1	0.1 uF	Capacitor – Ceramic, 0.1 uF, 10%, 16V, X7R, 0603	AVX	0603YC104KAT2A
C3, C4, C5 <sup>(1)</sup>	2-3	0.01 uF	Capacitor – Ceramic, 0.01 uF, 10%, 50V, X7R, 0603	AVX	06035C103KAT2A
D1-D8 <sup>(2)</sup>	4-8	130W	Diode – Bidirectional, 130W, ESD Protection, SOD323	NXP	PESD5V0S1BA
R1	1	20 KΩ	Resistor – 20 KΩ, 1/10W, 5%, 0603	Yageo America	RC0603JR-0720KL
U1	1	N/A	Touch controller IC	Microchip	AR1011 or AR1021

## TABLE B-1: BILL OF MATERIALS

**Note 1:** C5 is only needed for 5-wire applications.

- 2: D1-D8 are for ESD protection.
  - 4-wire touch screen, use D1-D4
  - 5-wire touch screen, use D1-D5
  - 8-wire touch screen, use D1-D8

See **Section 3.8 "ESD Considerations**" and **Section 3.9 "Noise Considerations**" for important information regarding the capacitance of the controller schematic hardware.

## INDEX

## Numerics

4, 5, 8-Wire Sensor Selection	12
4-Wire Sensor	7
4-Wire Touch Sensor Interface	12
4-Wire Touch Sensor Interface	12
5-Wire Sensor	
5-Wire Touch Sensor Interface	13
8-Wire Sensor	9
8-Wire Touch Sensor Interface	

## Α

Absolute Maximum Ratings	
Addressing	
Application Notes	45
Applications	5
AR1011/AR1021 Storing Default Calibration Values	
to EEPROM	
AR1020 Write Conditions	19

## В

Basics7	
Basics of Resistive Sensors7	

## С

Calibration of Touch Sensor with Controller	45
Clock Stretching	19
Command Protocol	20
Commands	35
Communication	17
Communications	3
Configuration Registers	25, 29
Customer Change Notification Service	67
Customer Notification Service	67
Customer Support	67

## D

Data Flow	2
Device Overview	5

## Е

Electrical Specifications	51
Errata	4
•	

# G General 7 H 11 Hardware 11 I 12C Hardware Interface 17 I2C Pin Voltage Level Characteristics 18 Internet Address 67 M 11 Master Read Bit Timing 18 Master Write Bit Timing 19 Microchip Internet Web Site 67 N Noise Considerations 15

## Ρ

Packaging	
Marking	
Power Requirements	

## R

Reader Response	68
Register Descriptions	
Restoring Default Parameters	29
Revision History	63

## S

Sending Commands	35
Sleep State	20
Special Features	3
SPI Bit Timing - General	23
SPI Communications	21
SPI Hardware Interface	21
SPI Pin Voltage Level Characteristics	22
Status LED	15

## Т

-	
Terminology	7
Timing – Bit Details	
Touch Modes	
Touch Report Protocol	
Touch Report Protocol	
Touch Reporting Protocol	27
Touch Resolution	
Touch Sensor Support	

## U

UART Communications	25

## W

Wake Pin	15
WWW Address	67
WWW, On-Line Support	

NOTES:

## THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- **Product Support** Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

## **CUSTOMER SUPPORT**

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support
- Development Systems Information Line

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

## READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

TO: RE:	Technical Publications Manager Reader Response	Total Pages Sent
Fror	n: Name	
	Company	
	Address	
	City / State / ZIP / Country	
	Telephone: ()	FAX: ()
Арр	lication (optional):	
Wou	Ild you like a reply?YN	
Dev	ice: AR1000 Series Resistive Touch Screen Controller	Literature Number: DS41393B
Que	stions:	
1.	What are the best features of this document?	
2.	How does this document meet your hardware and softwa	are development needs?
3.	B. Do you find the organization of this document easy to follow? If not, why?	
4.	. What additions to the document do you think would enhance the structure and subject?	
5.	What deletions from the document could be made without affecting the overall usefulness?	
6.	Is there any incorrect or misleading information (what an	d where)?
7.	How would you improve this document?	

NOTES:



## Worldwide Sales and Service

#### AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

**Chicago** Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

**Cleveland** Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

**Dallas** Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto Mississauga, Ontario, Canada Tel: 905-673-0699 Fax: 905-673-6509

## ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431 Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

**China - Chongqing** Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou Tel: 86-571-2819-3187

Fax: 86-571-2819-3189 China - Hong Kong SAR Tel: 852-2401-1200

Fax: 852-2401-3431

**China - Nanjing** Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

**China - Qingdao** Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

**China - Shenzhen** Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

## ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

**India - New Delhi** Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

**Japan - Osaka** Tel: 81-66-152-7160 Fax: 81-66-152-9310

**Japan - Yokohama** Tel: 81-45-471- 6166 Fax: 81-45-471-6122

**Korea - Daegu** Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

**Malaysia - Penang** Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

**Singapore** Tel: 65-6334-8870 Fax: 65-6334-8850

**Taiwan - Hsin Chu** Tel: 886-3-5778-366 Fax: 886-3-5770-955

**Taiwan - Kaohsiung** Tel: 886-7-536-4818 Fax: 886-7-330-9305

Taiwan - Taipei Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

**Thailand - Bangkok** Tel: 66-2-694-1351 Fax: 66-2-694-1350

## EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

**Italy - Milan** Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

**UK - Wokingham** Tel: 44-118-921-5869 Fax: 44-118-921-5820

11/29/11

## 22 Mar 2012 Data Sheet - AR1000 Series Resistive Touch Screen Controller Data Sheet

## SYST-22GASE724

Microchip has released a new DeviceDoc for the AR1000 Series Resistive Touch Screen Controller Data Sheet of devices. If you are using one of these devices please read the document located at AR1000 Series Resistive Touch Screen Controller Data Sheet.

## Attachments:

AR1000 Series Resistive Touch Screen Controller Data Sheet

Please contact your local Microchip sales office with questions or concerns regarding this notification.

## **Terms and Conditions:**

If you wish to change your product/process change notification (PCN) profile please log on to our website at <a href="http://www.microchip.com/PCN">http://www.microchip.com/PCN</a> sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to microchipDIRECT and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."